

1. Schematic Page Description :

ZHQ/Hugo Schematic Ver : 1.0

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- 11 -- Valley 9/9 (GND)
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- 14 -- DDR3L MEMORY DOWNx16 CHB
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- 18 -- LCD/CCD/DMIC
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- 22 -- eMMC
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- 24 -- DB /Thermal sensor
- 25 -- Audio Codec
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- 28 -- KBC
- 29 -- Charger (BQ24715RGRR)
- 30 -- SYSTEM 5V/3V (MPS670/671)
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I2C table

Function	Channel	Read	Write
Touch pad	I2C0	0x67	
Audio codec	I2C1	0x21	0x20
Light sensor	I2C4		

SMBus table

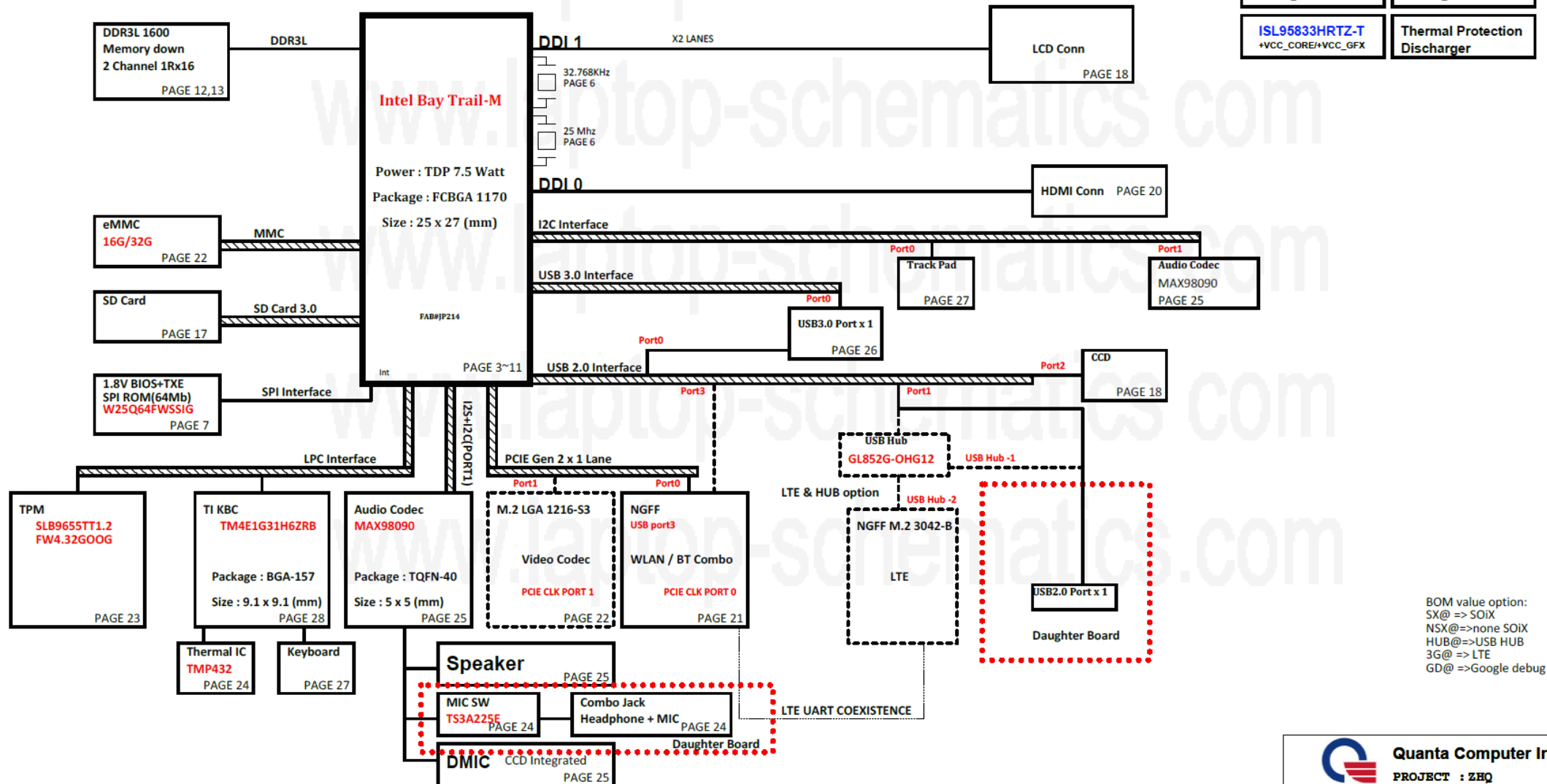
Function	Channel	Address
Battery	SMB0	
Thermal	SMB2	0x4C

Function	Channel
PP3300_DSW	0x42
PP5000	0x41
PP1350	0x49
PP1050_PCH	0x43
PP1000_PCH	0x47

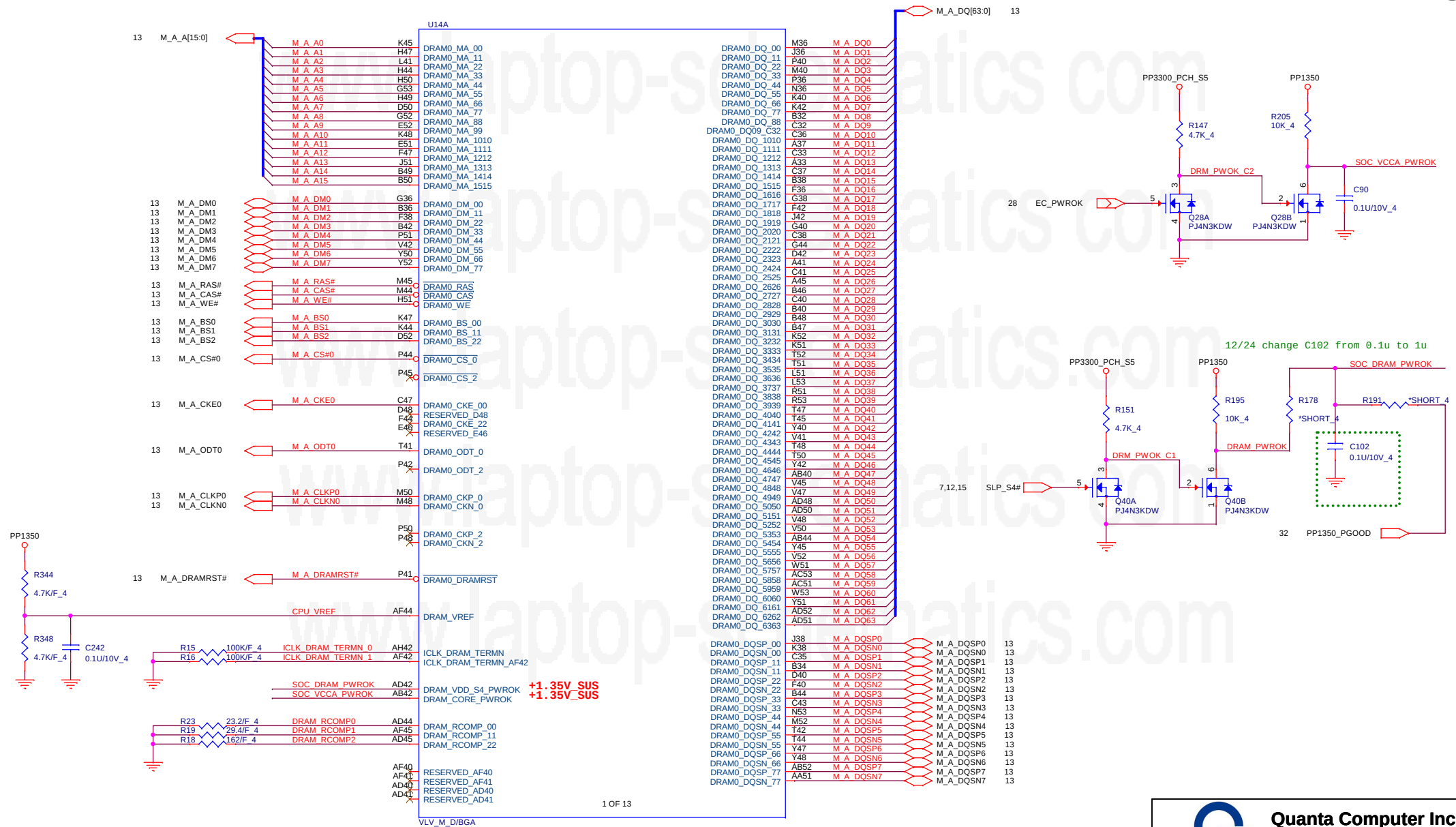
ZHQ/Hugo

Intel Bay Trail-M Platform Block Diagram

SKU# DC N2820
AJSR1SGUT03 --CPU(1170P)N2820 2.13G SR1SG(FCBGA)STNBSQ



BOM value option:
SX@ => SOiX
NSX@=>none SOiX
HUB@=>USB HUB
3G@ => LTE
GD@ =>Google debug

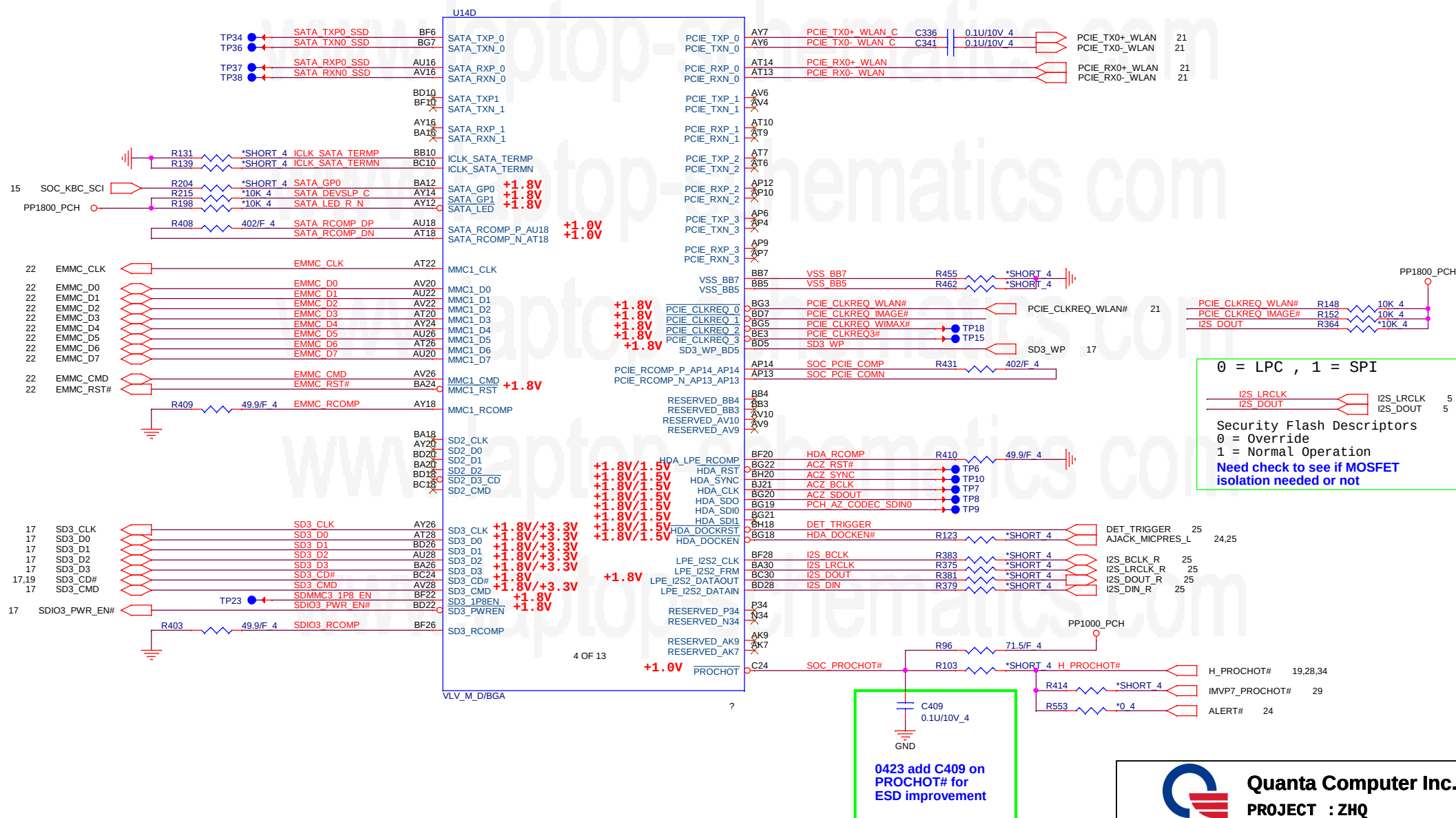


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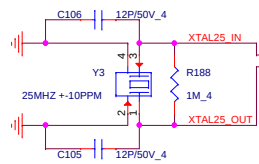
PROJECT : ZHQ

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	Valley 1/9 (DDRA)	1A
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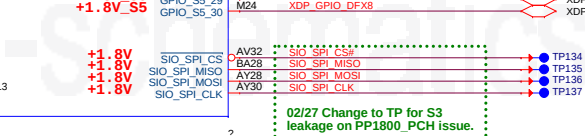
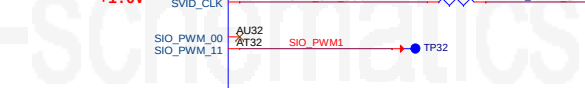
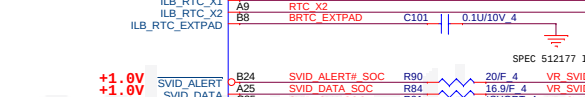
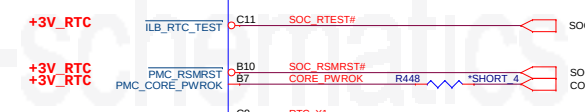
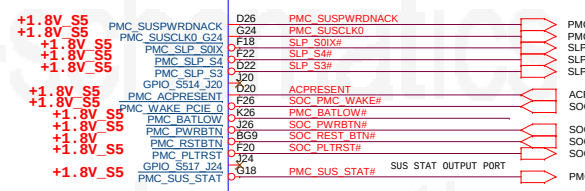
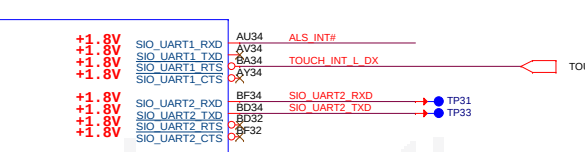
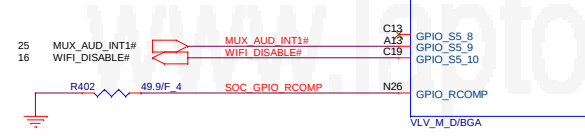
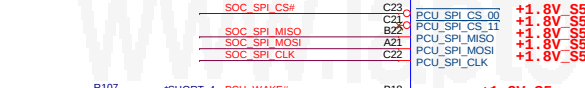
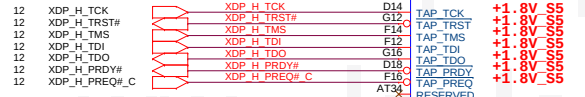
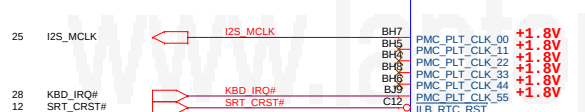
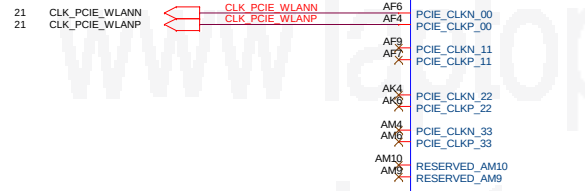
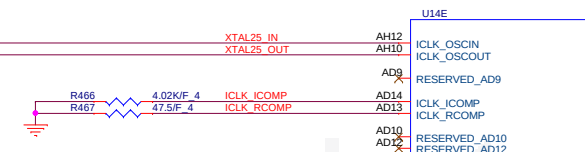
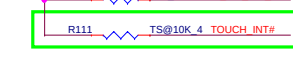
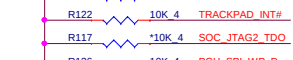
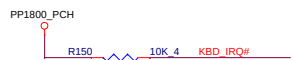




CRYSTAL 25MHZ

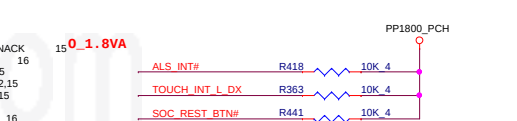
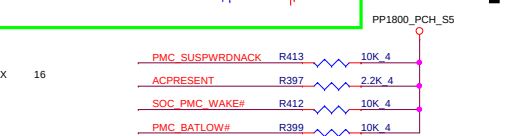


2nd BG625000121(HHE)



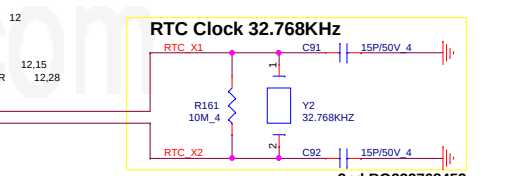
0423 add C408 on CORE_PWROK for ESD improvement

CORE_PWROK C408 0.1U/10V_4 I/GND

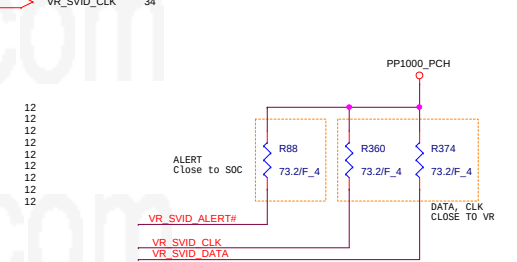


SOC_REST_BTN# R468 *SHORT_4 EC_REST_L

9/6 Add EC_REST_L for warm boot, EC side is 0D type



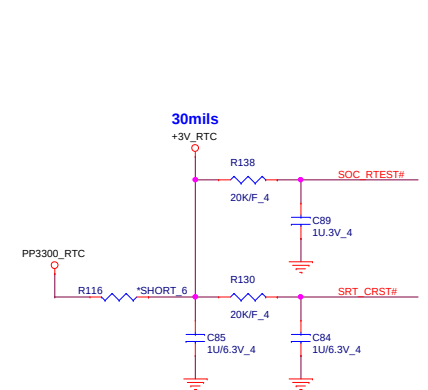
2nd BG332768453



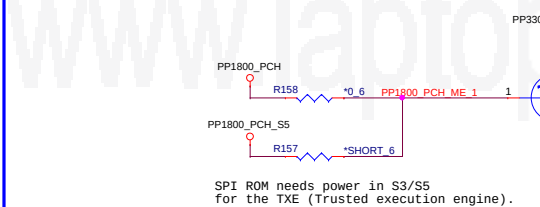
ALERT Close to SOC

DATA, CLK CLOSE TO VR

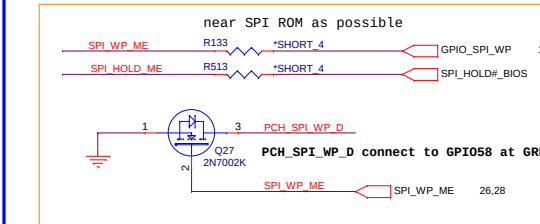
RTC Circuitry(RTC)



SPI_FLASH



SPI ROM needs power in S3/S5 for the TXE (Trusted execution engine).

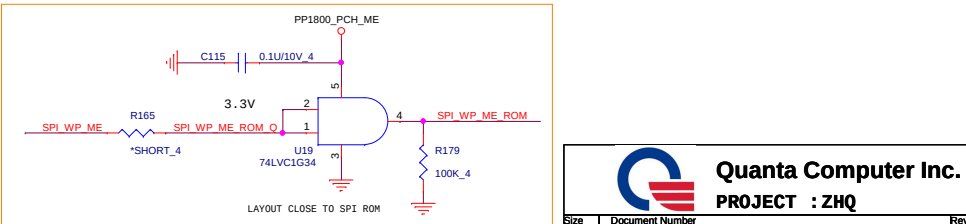
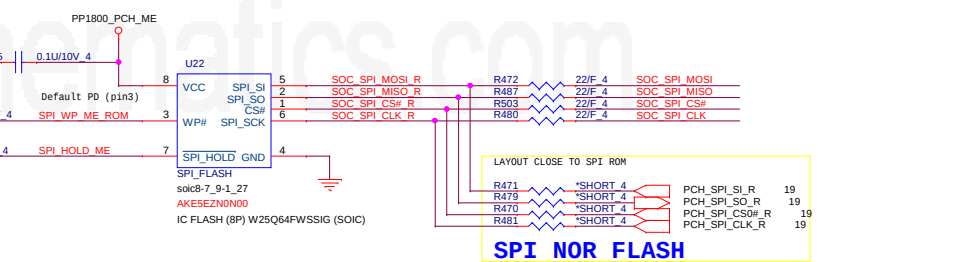


To debug header

To PCH

From Screw/EC

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SPI NOR FLASH

LAYOUT CLOSE TO SPI ROM

LAYOUT CLOSE TO SPI ROM

LAYOUT CLOSE TO SPI ROM

LAYOUT CLOSE TO SPI ROM

LAYOUT CLOSE TO SPI ROM

LAYOUT CLOSE TO SPI ROM

LAYOUT CLOSE TO SPI ROM

LAYOUT CLOSE TO SPI ROM

LAYOUT CLOSE TO SPI ROM

Vender	RAM ID 210	Q P/N	Mfr. PN	Freq.	Size	Pice
Micron	0x000		MT41K256M16HA-125	1600MHZ	4GB	8
Hynix	0x001	AKD5JGETW04	H5TC4663AFR-PBA	1600MHZ	4GB	8
Micron	0x010	AKD5D6STL07	MT41K128M16JT-125M:K	1600MHZ	2GB	8
Hynix	0x011	AKD5PGSTW03	H5TC4663MFR-PBA	1600MHZ	2GB	4
Micron	0x100		MT41K256M16HA-125	1600MHZ	2GB	4
Hynix	0x101	AKD5JGETW04	H5TC4663AFR-PBA	1600MHZ	2GB	4
Kingston	0x110	AKD5PZ2TP02	D2516EC48XGGB	1600MHZ	4GB	8
Hynix	0x111	AKD5PGSTW03	H5TC4663MFR-PBA	1600MHZ	4GB	8

PP1800_PCH_S5

RAM ID

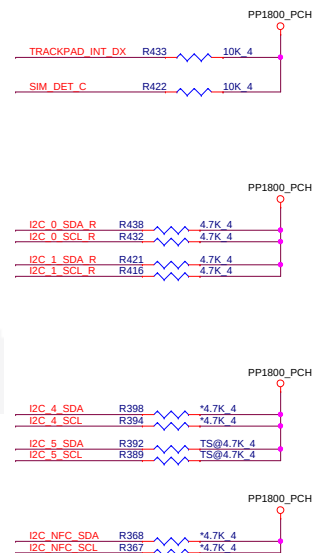
R186 *1K 4 RAM_ID0 R202 1K 4

R187 1K 4 RAM_ID1 R203 1K 4

R196 1K 4 RAM_ID2 R192 1K 4

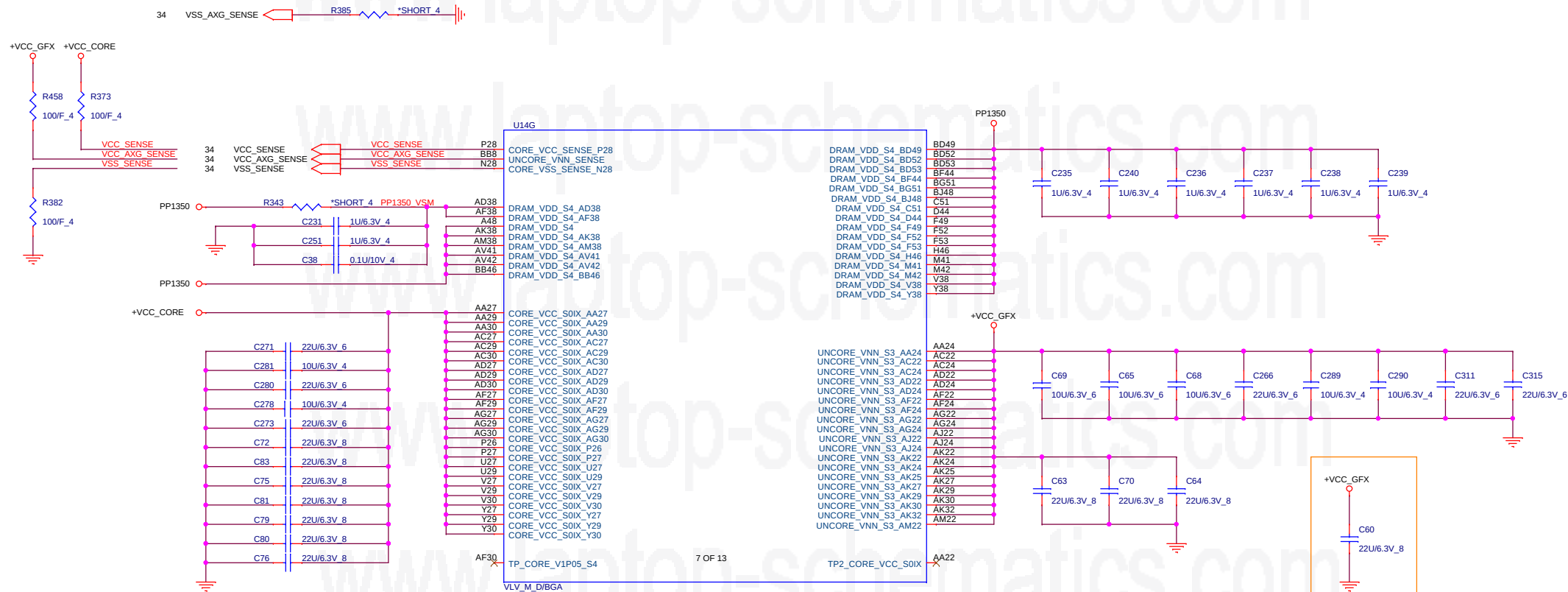
R612 1K 4 RAM_ID3 R613 1K 4

R2127 Reserve RAM_ID3 for memory BOM option.

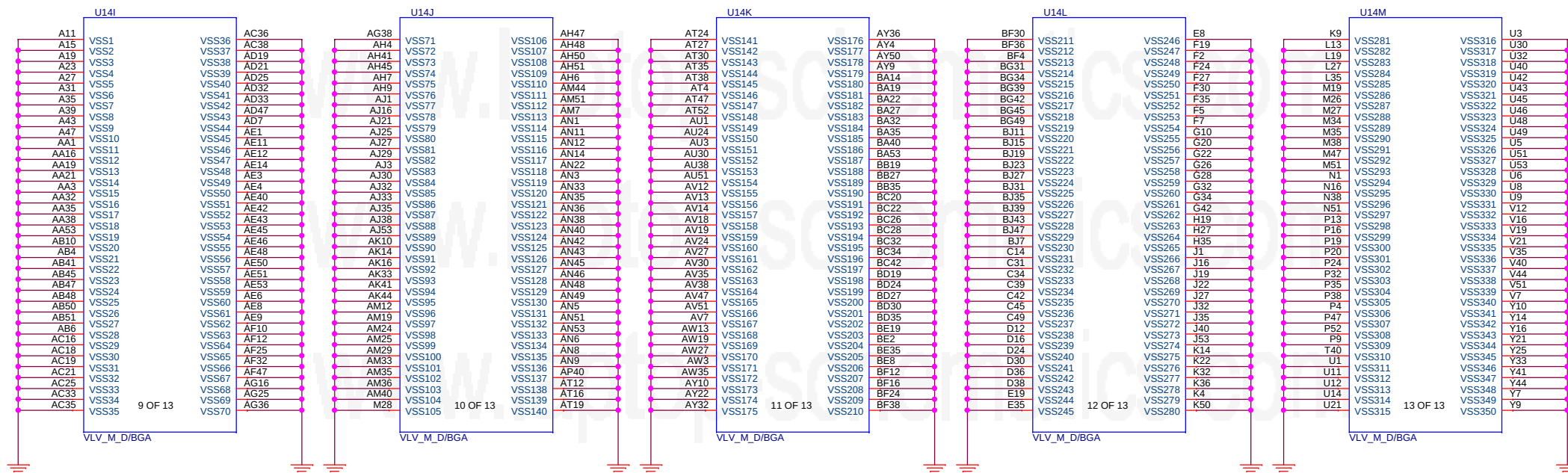


1031 for layout suggestion by intel,
VSS_AXG_SENSE didn't connect to VSS_SENSE,
will connect the GND via near VCC_AXG_SENSE

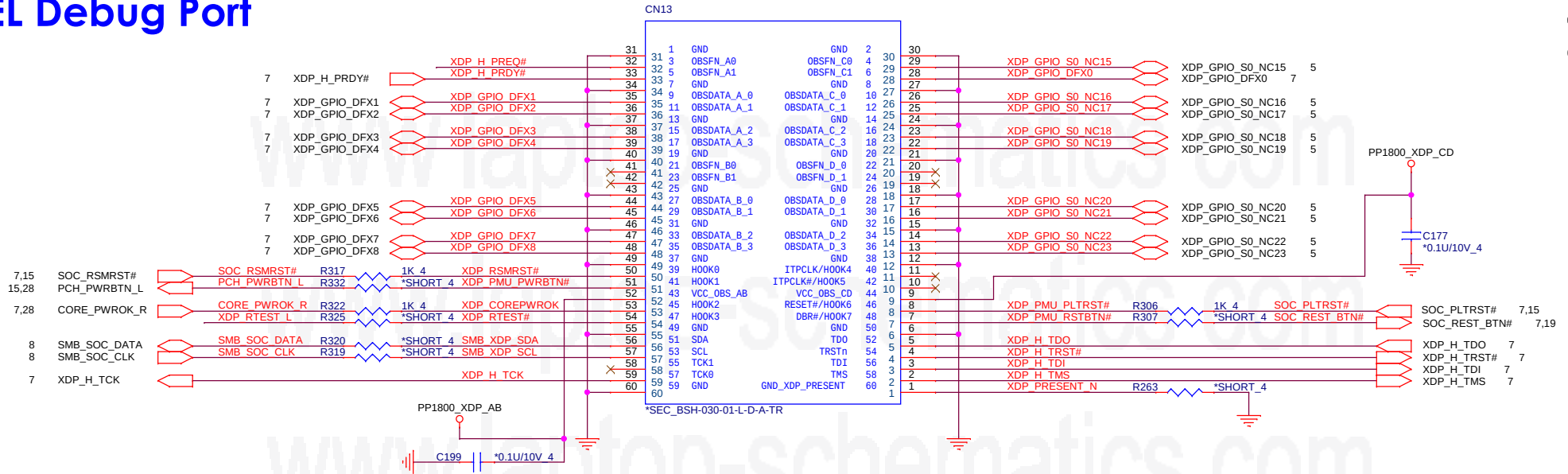
1031 for layout, add 0hm between
GND and VSS_AXG_SENSE



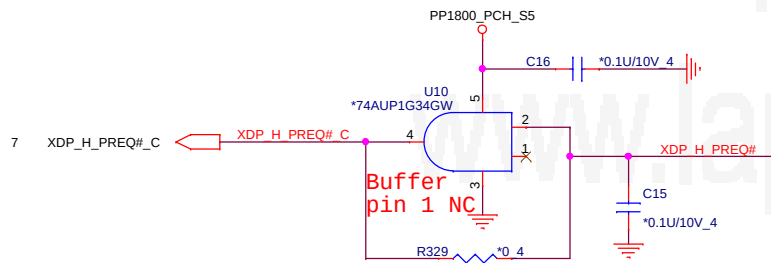




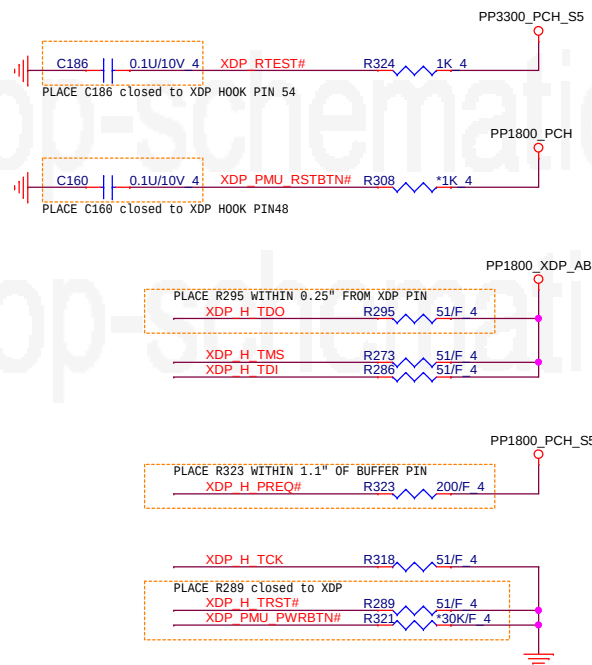
INTEL Debug Port



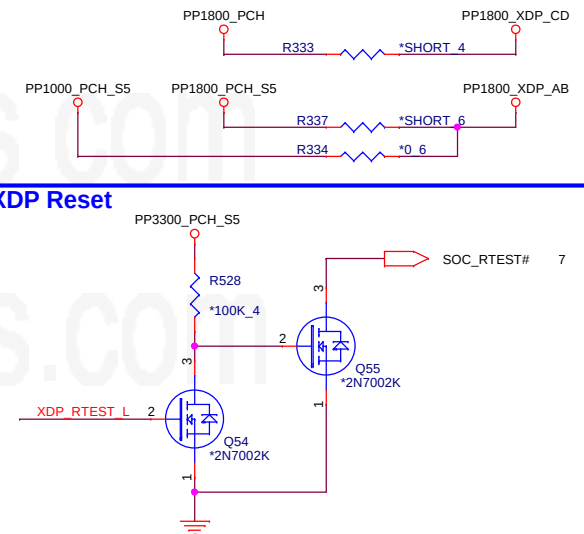
XDP



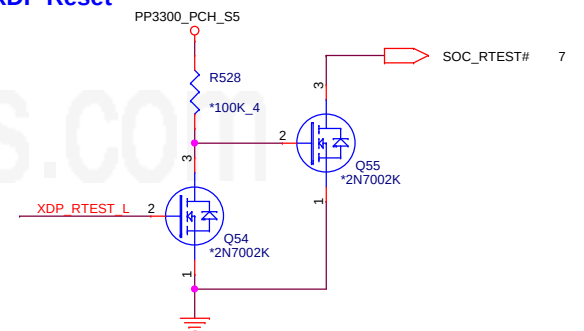
XDP



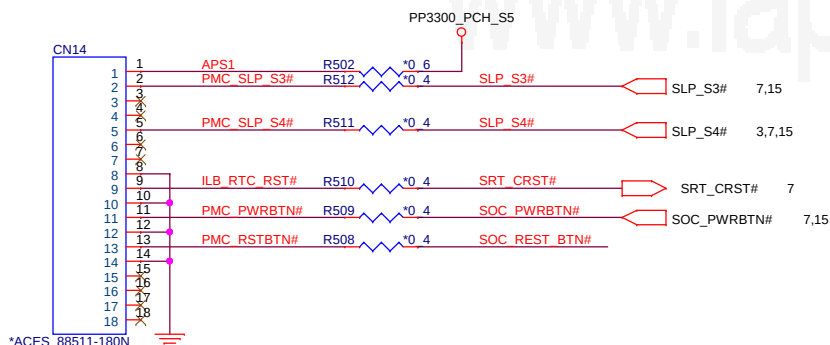
INTEL Debug Port Power



XDP Reset



APS



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<DDR>

BYTE2_16-23

BYTE1_8-15

BYTE0_0-7

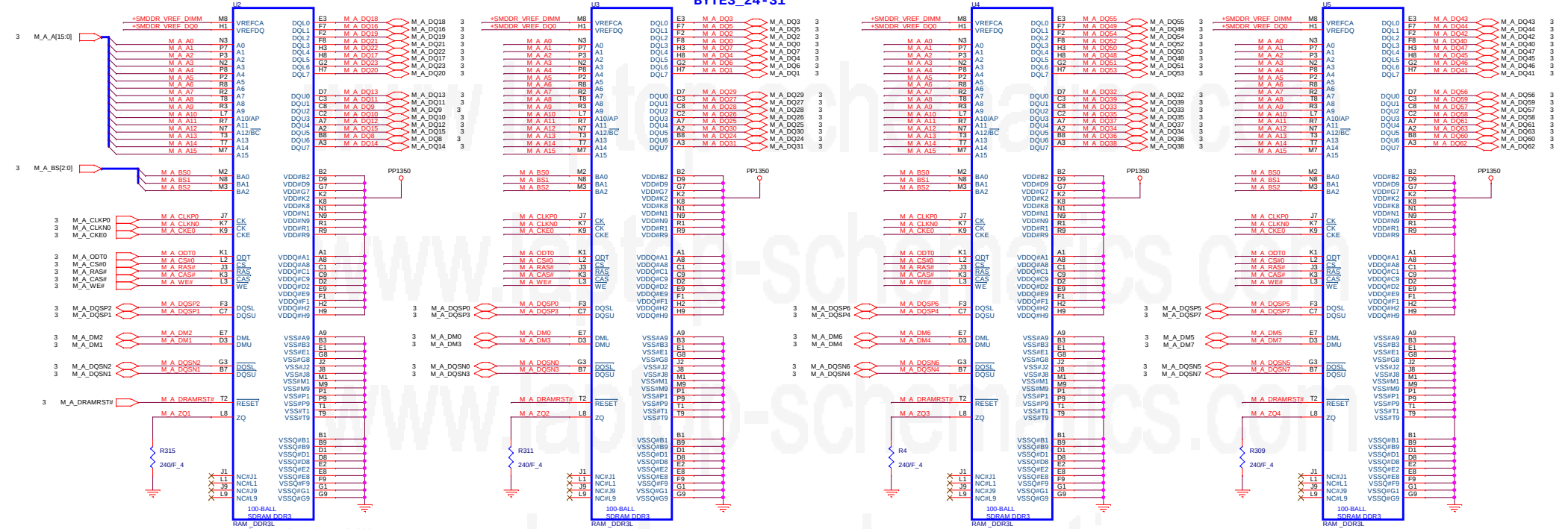
BYTE3_24-31

BYTE4_32-39

BYTE6_48-55

BYTE5_40-47

BYTE7_56-63

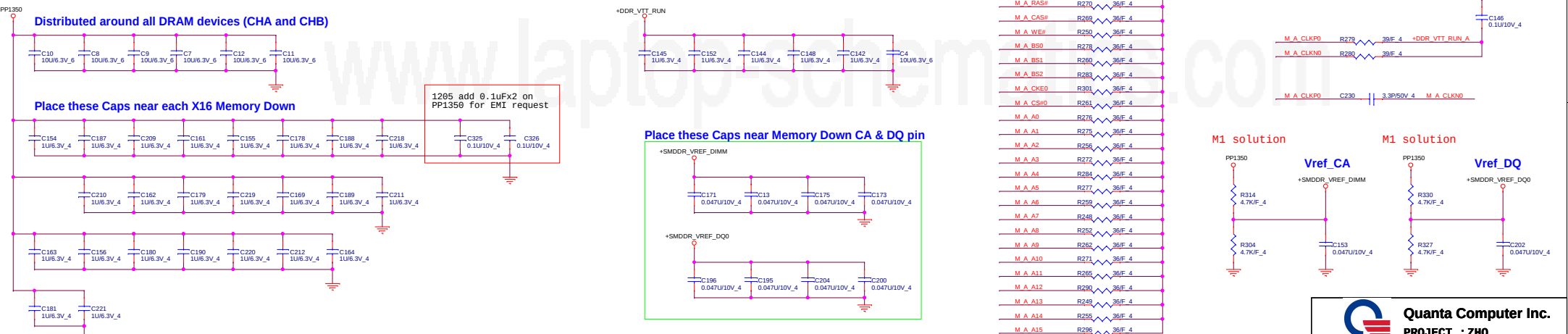


Distributed around all DRAM devices (CHA and CHB)

Place these Caps near each X16 Memory Down

1205 add 0.1uFx2 on PP1350 for EMI request

Place these Caps near Memory Down CA & DQ pin



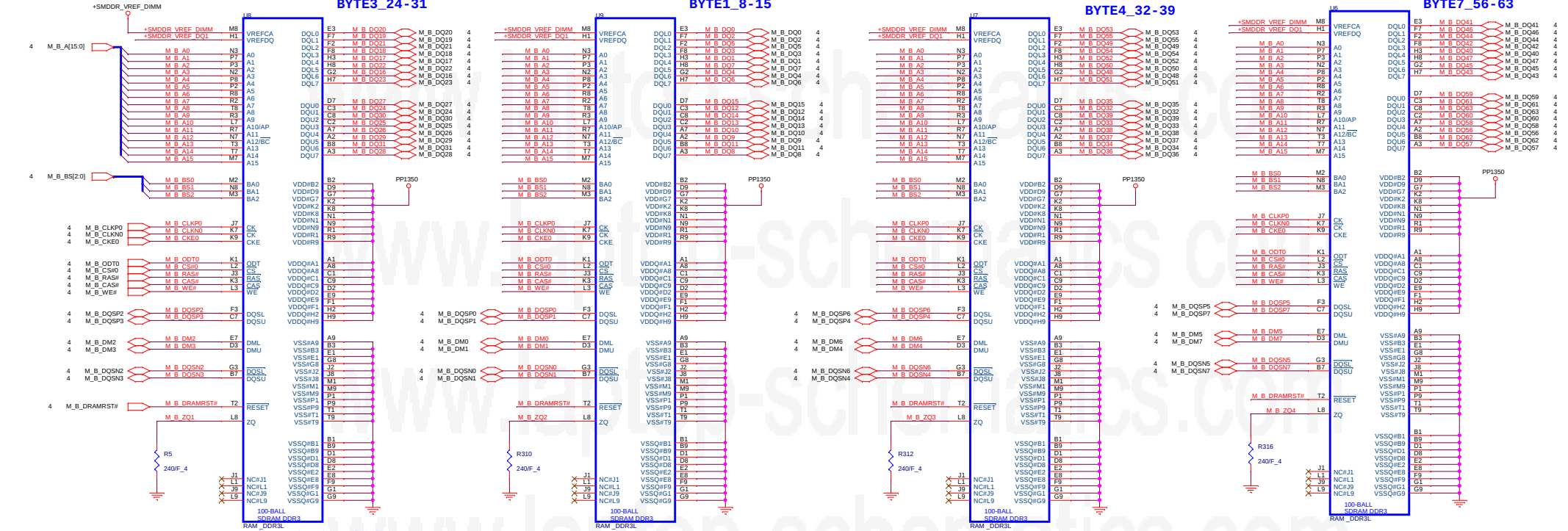
<DDR>

BYTE16_23
BYTE24_31

BYTE0_7
BYTE18_15

BYTE6_48-55
BYTE4_32-39

BYTE5_40-47
BYTE7_56-63



Hynix AKD5JGETW04-H5TC4G63AFR-PBA

Vendor	P/N	
Hynix	AKD5JGETW04	DDR3L 1600MHz 4Gb
Elpida	AKD5JGST400	DDR3L 1333MHz 4Gb
	AKD5JGST404	DDR3L 1333MHz 4Gb

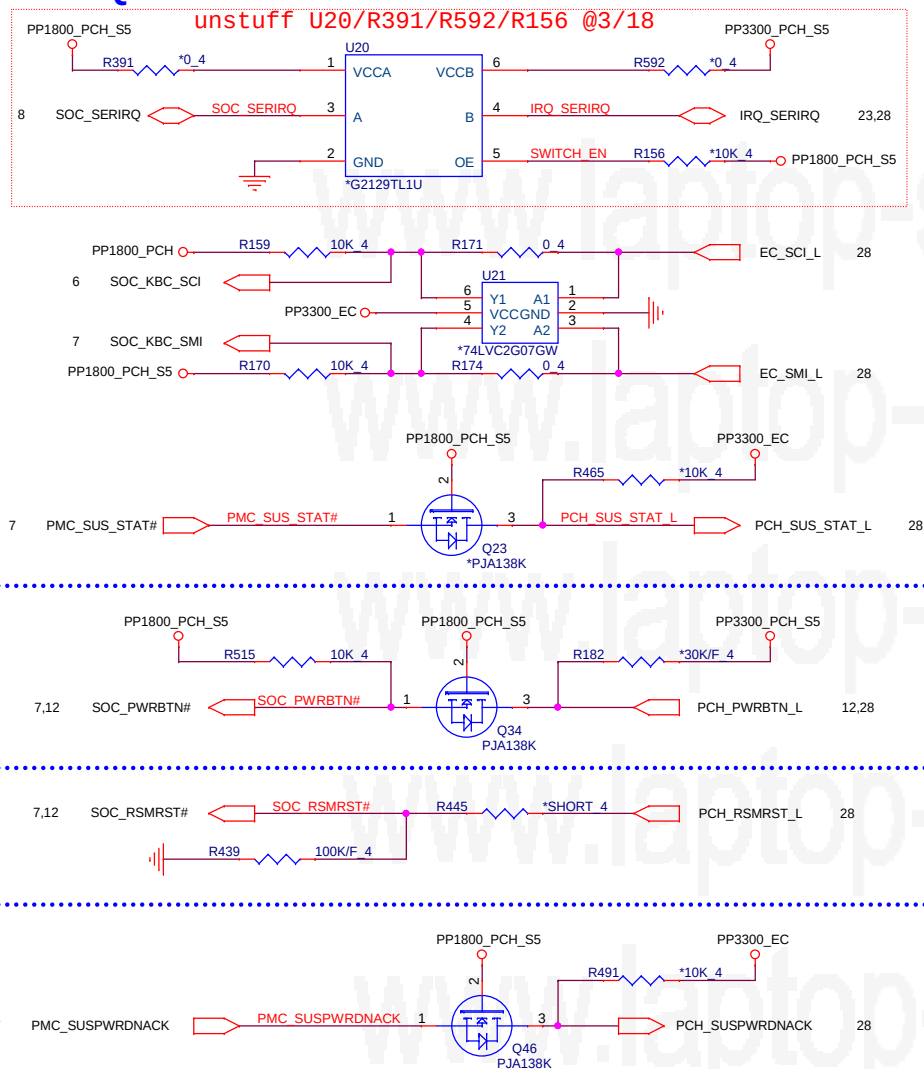
Place these Caps near each X16 Memory Down

Place these Caps near Memory Down CA & DQ pin

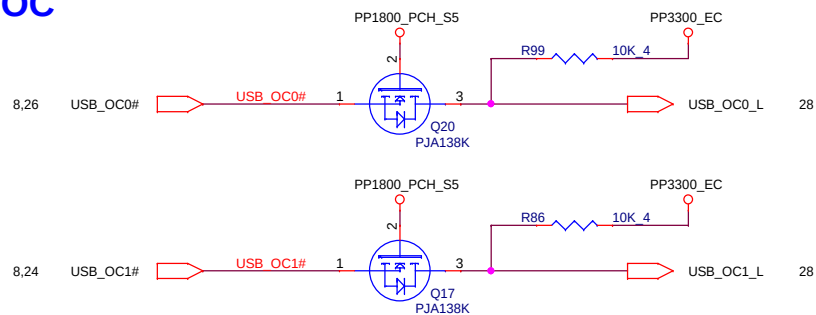
M1 solution

Vref_DQ

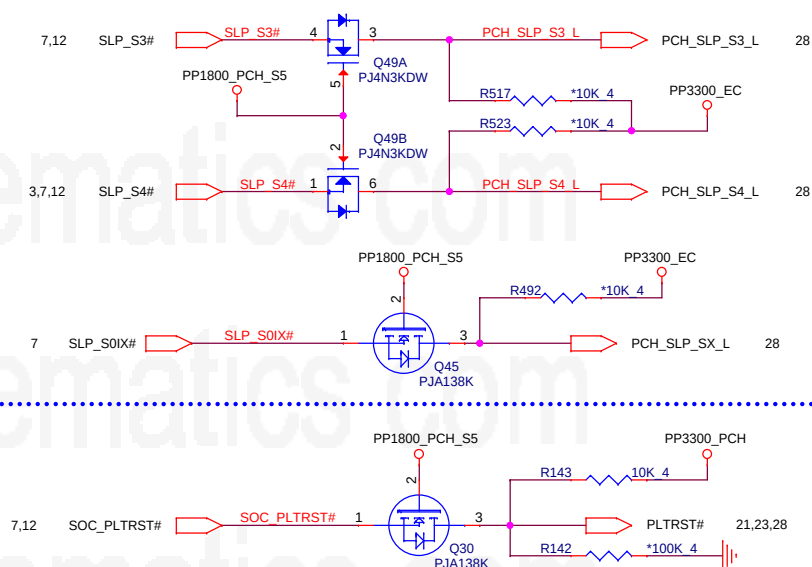
5
PWRON SEQUENCE



USB OC

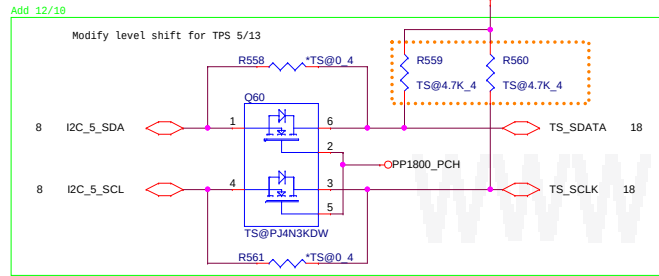


PWRON SEQUENCE

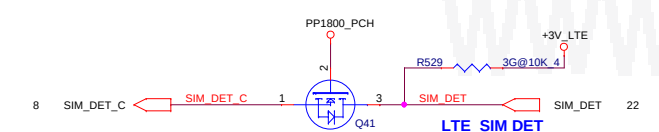
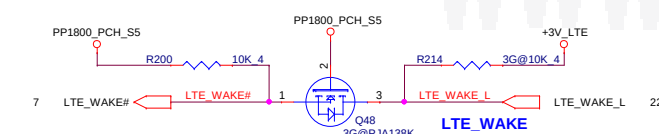
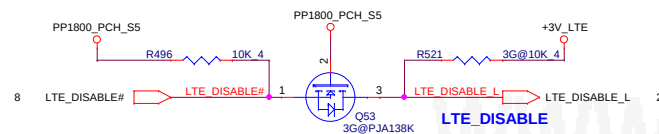
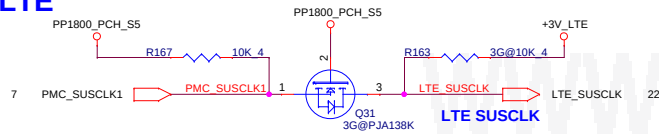


02/27 Cancel level shift for S3 leakage on PP1800_PCH issue.

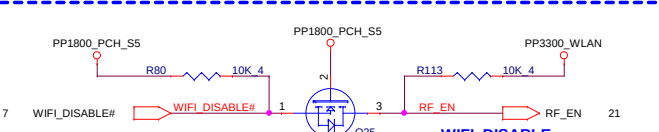
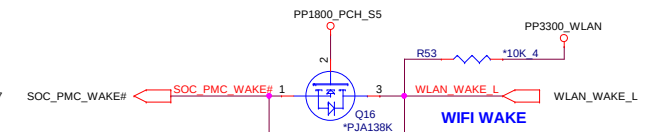
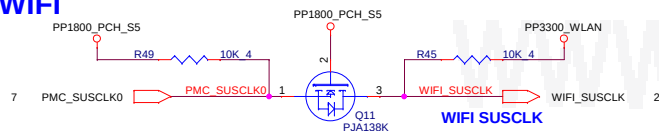
Touch Panel level shift(TPS)



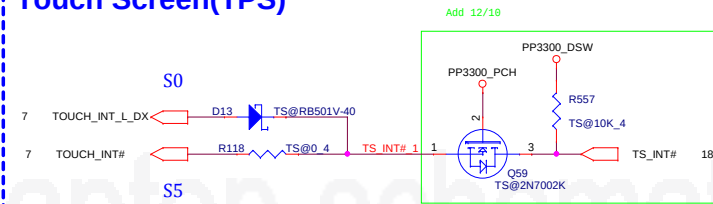
LTE



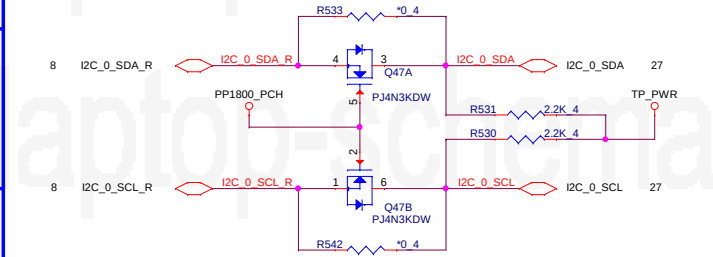
WIFI



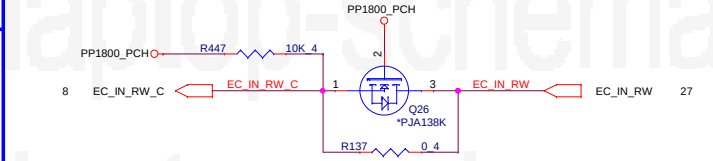
Touch Screen(TPS)



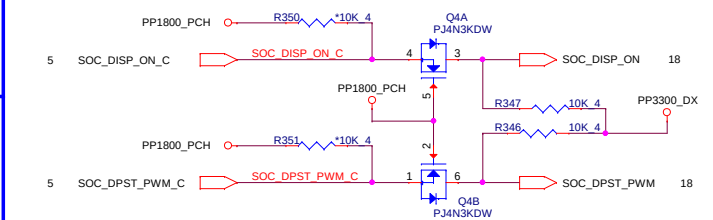
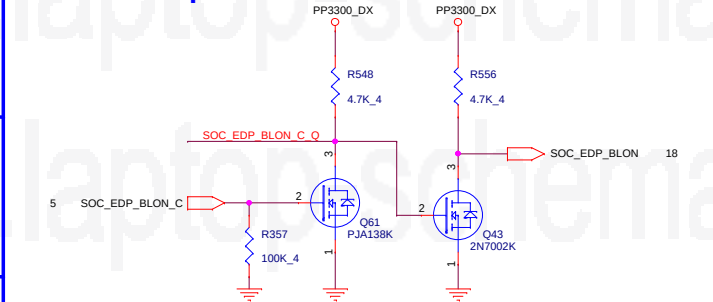
Track Pad



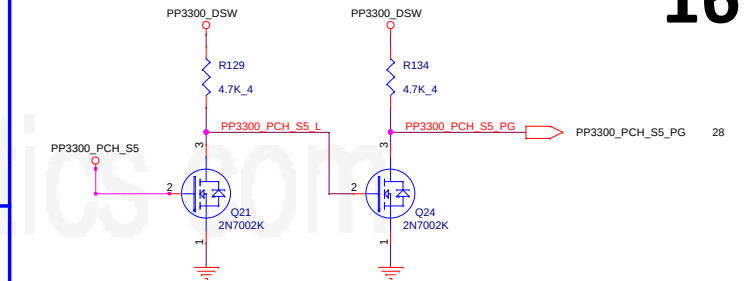
HW RESET



eDP control pin

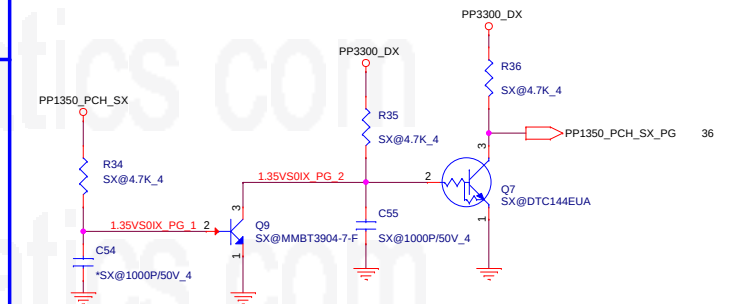
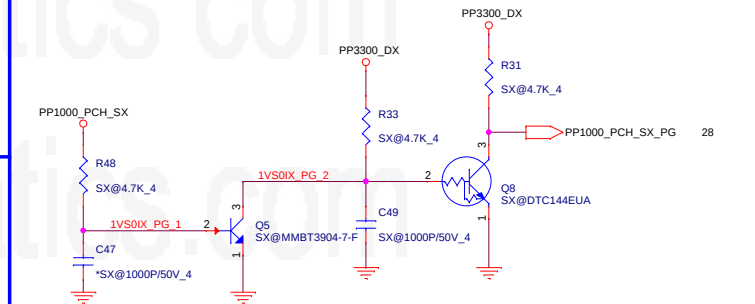


S5 Power Good(+3V_S5)

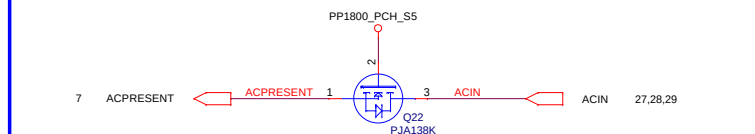


S0iX Power Good

for proto type only, can remove at MP stage if S0ix is not needed

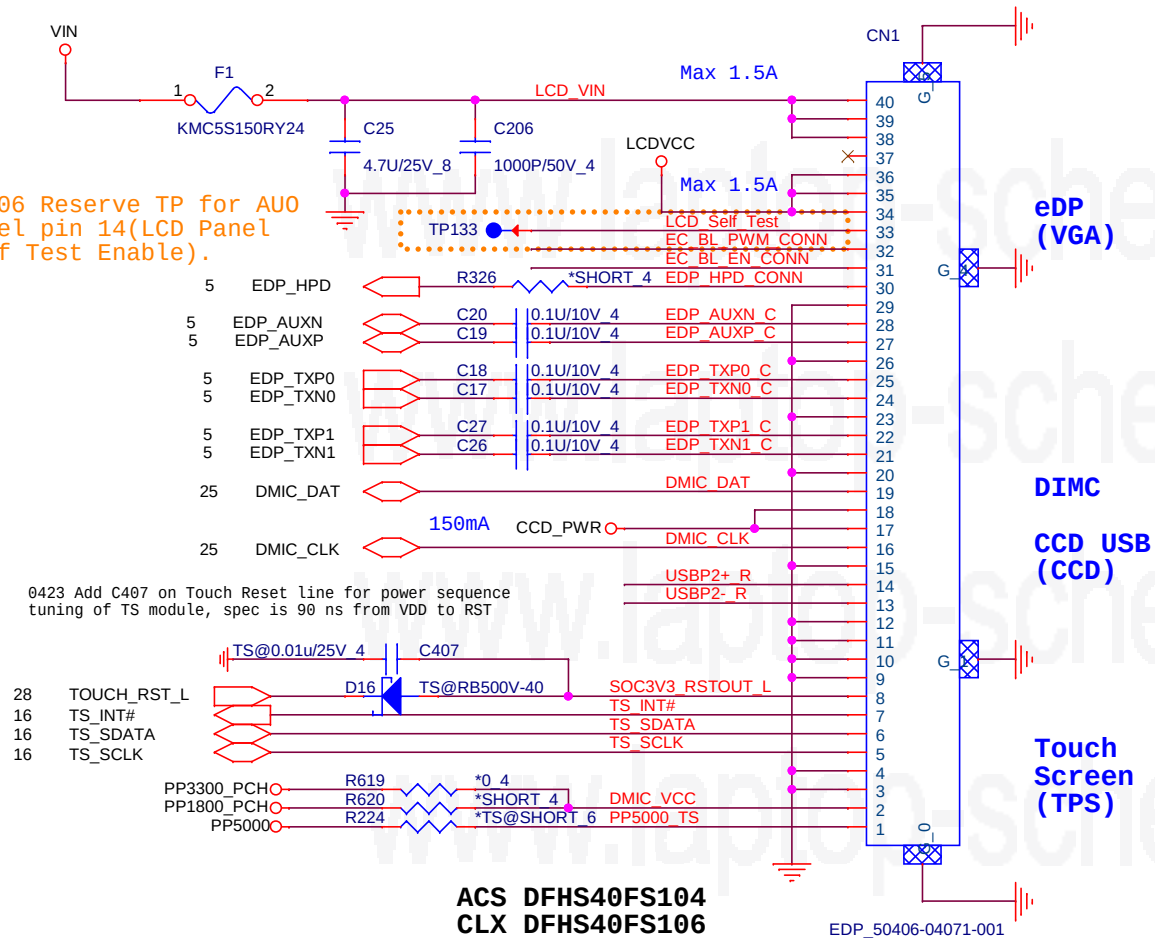


AC Detect



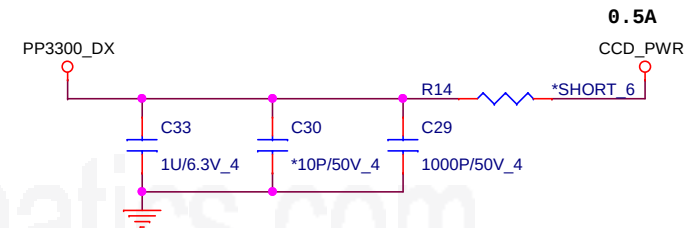
LCD CONN

02/06 Reserve TP for AU0 panel pin 14(LCD Panel Self Test Enable).

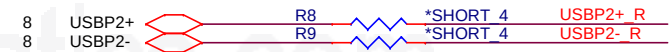


CCD Power(CCD)

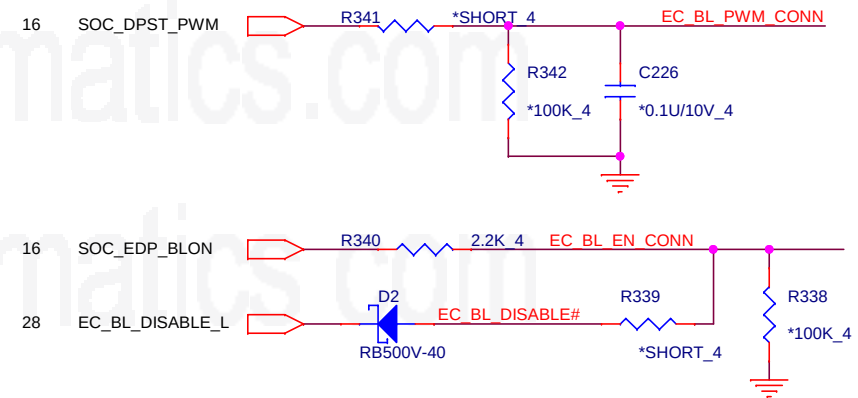
18



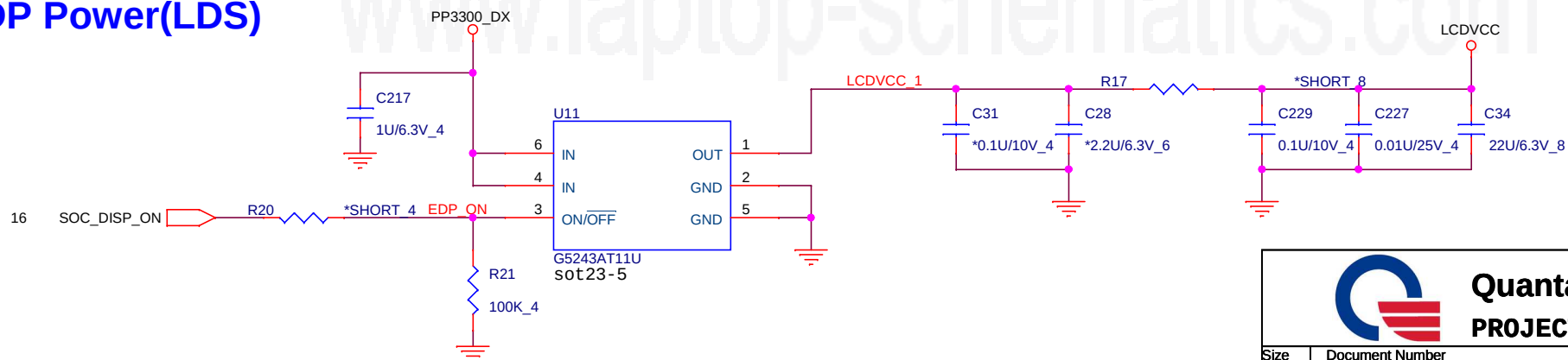
CCD USB(CCD)



eDP panel control(LDS)



eDP Power(LDS)



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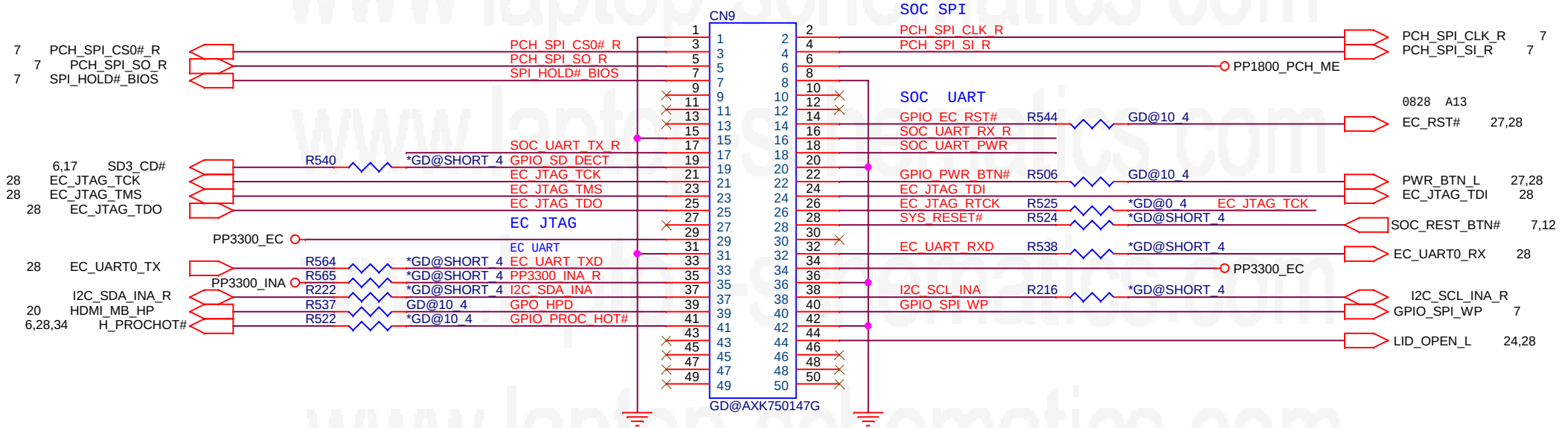
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GOOGLE Debug Port(MPC)

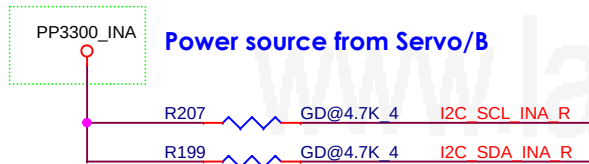
50 pin BTB is MUST, don't use 42 pin
Socket part number AXK750147G

PIN7	OD	PIN39	OD	PIN49	OD
PIN14	OD	PIN41	OD	PIN50	OD
PIN19	OD	PIN43	OD		
PIN22	OD	PIN44	OD		
PIN28	OD	PIN45	OD		
PIN30	OD	PIN46	OD		
PIN37	OD	PIN47	OD		
PIN38	OD	PIN48	OD		

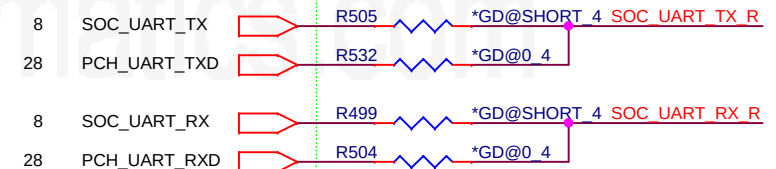
19



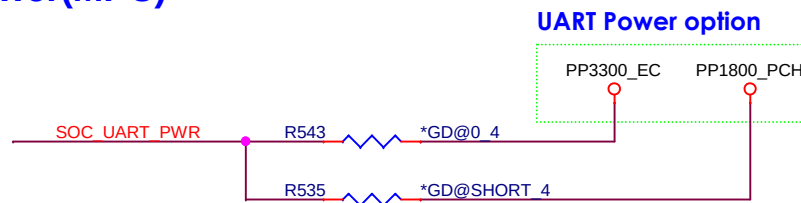
Servo/B I2C Power(MPC)



UART(MPC)

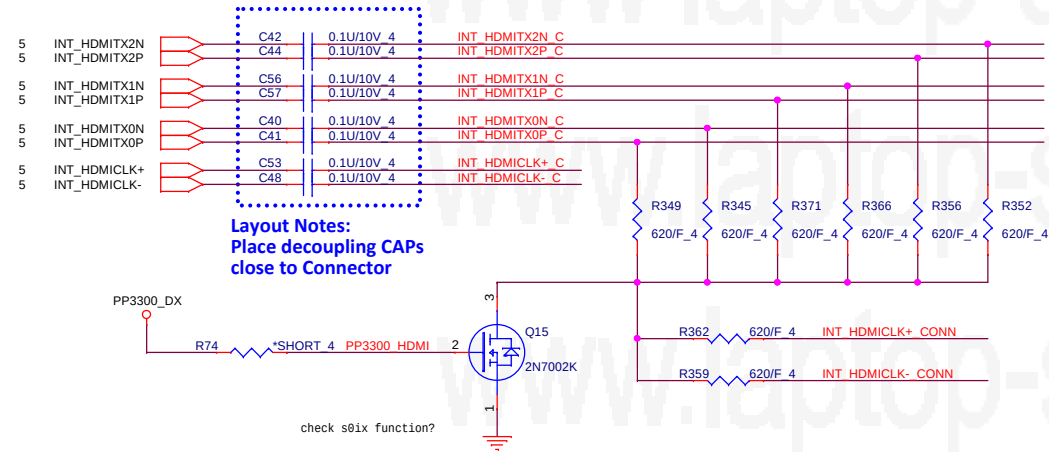


UART Power(MPC)

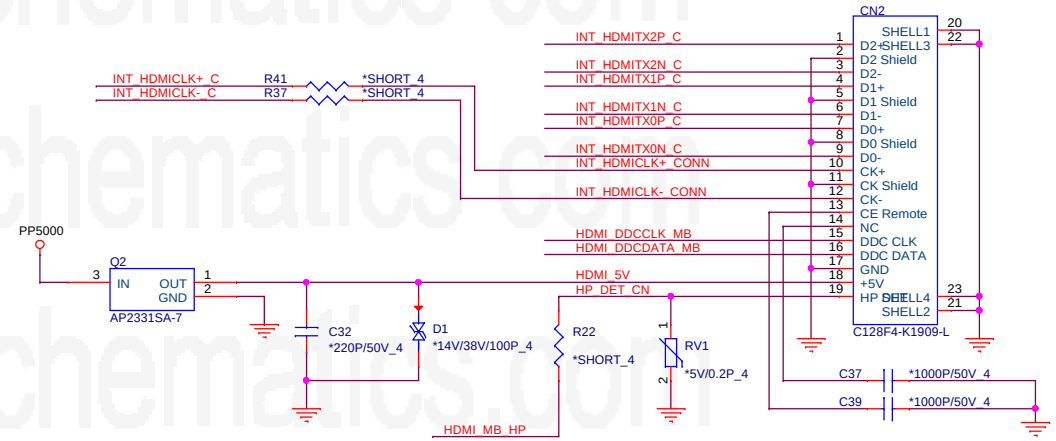


		
Quanta Computer Inc.		
PROJECT : ZHQ		
Size	Document Number	Rev 1A
Google Debug		
Date:	Thursday, July 03, 2014	Sheet 19 of 42

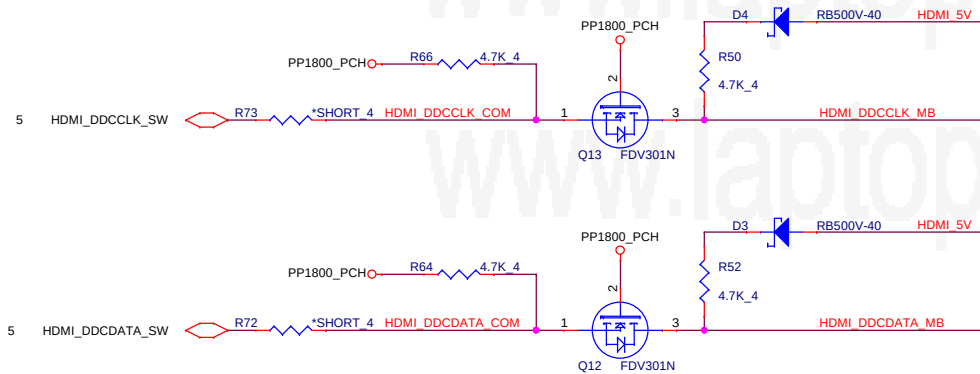
HDMI Cost Reduced level shift (HDM)



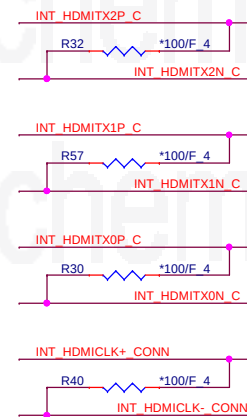
HDMI connector (HDM)



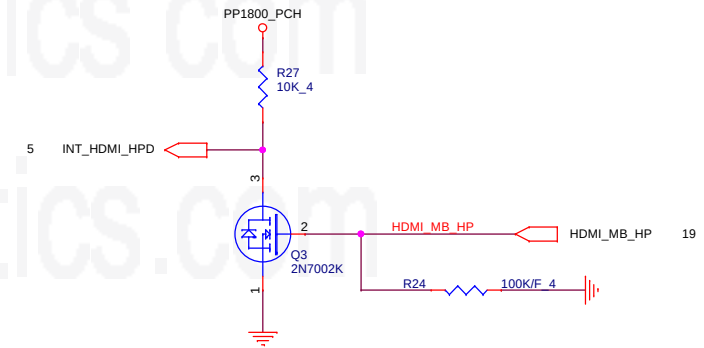
HDMI DDC (HDM)



EMI



HDMI-detect (HDM)



Quanta Computer Inc.

PROJECT : ZHQ

Size	Document Number	Rev
	HDMI	1A

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WIFI/BT COMBO NGFF E KEY(MNC)

21

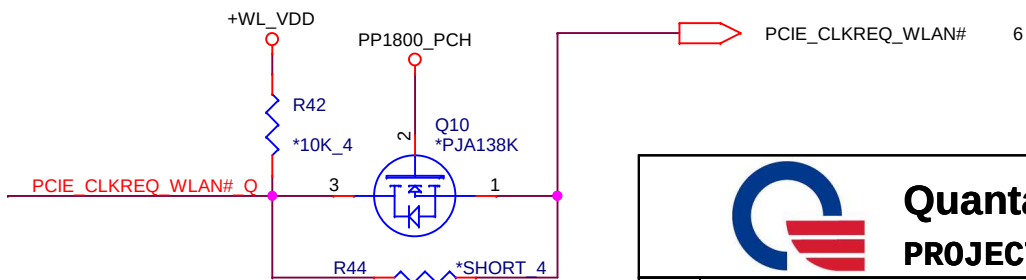
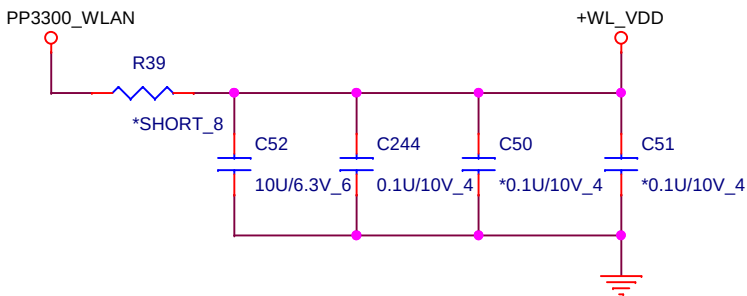
(Low Active)
(Low Active)

WLAN_OFF_L POWER DOWN LAN CHIP from EC?
WIFI_DISABLE_L disable Antenna from PCH?

+WL_VDD

02/05 Remove GPIO
and reserve TP.

WL/BT NGFF Power



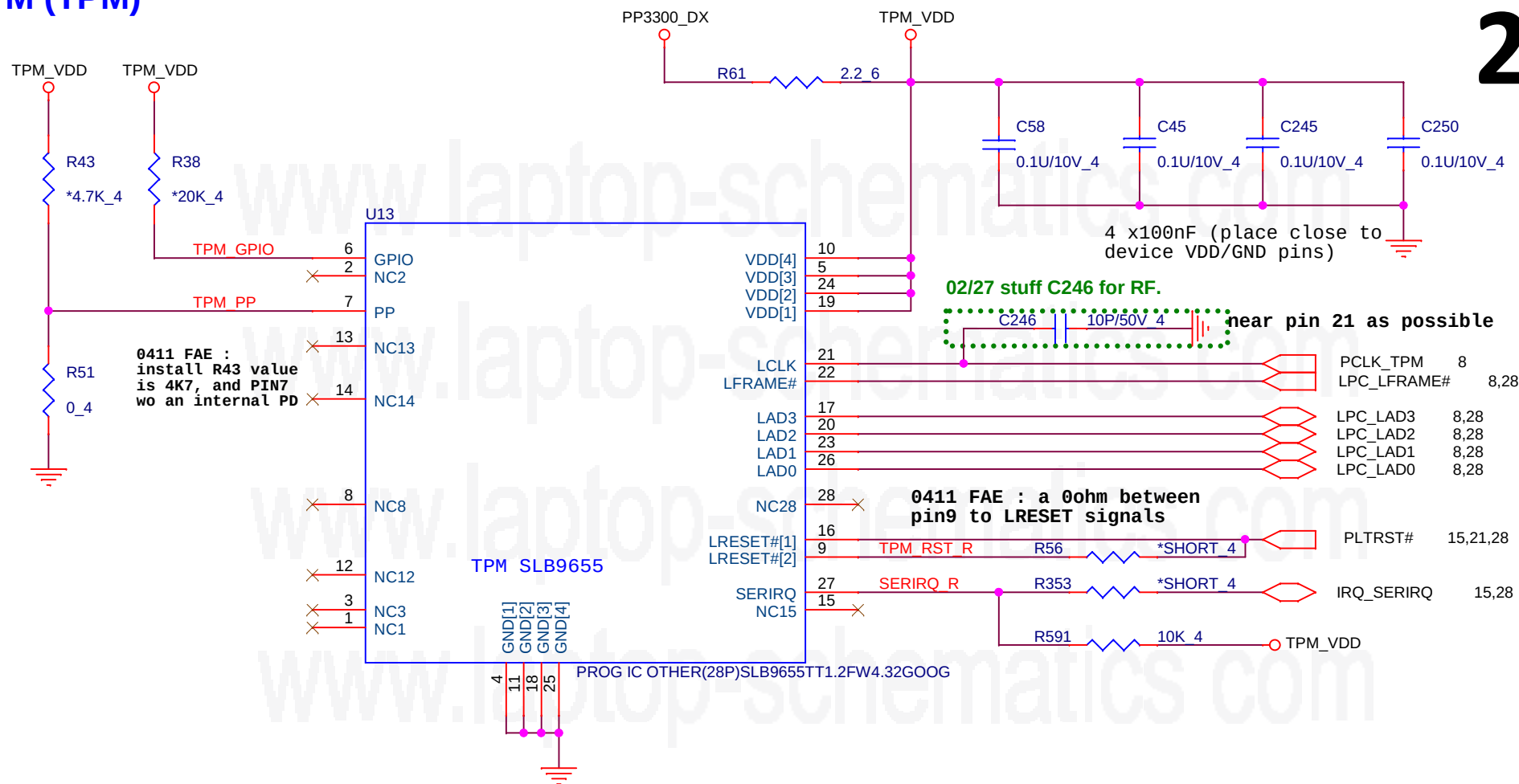


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PROJECT : ZHQ

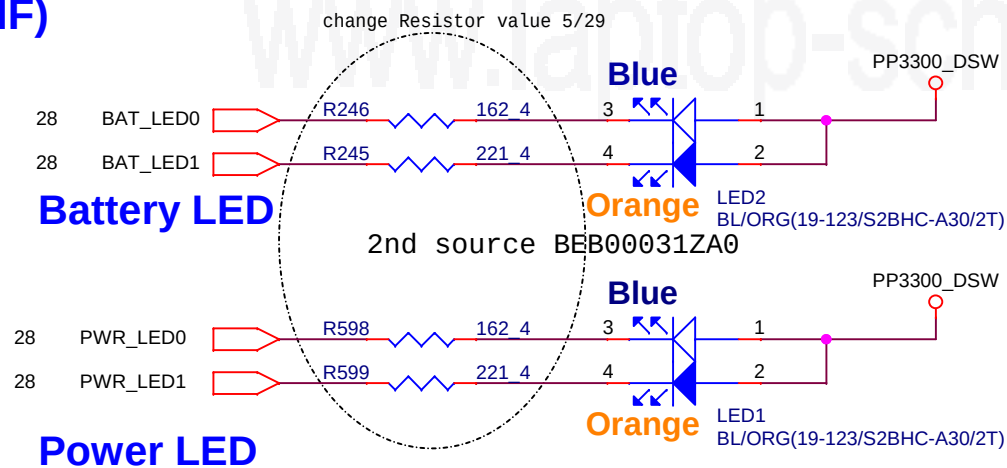
Size	Document Number	WIFI / BT
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TPM (TPM)



LED(UIF)

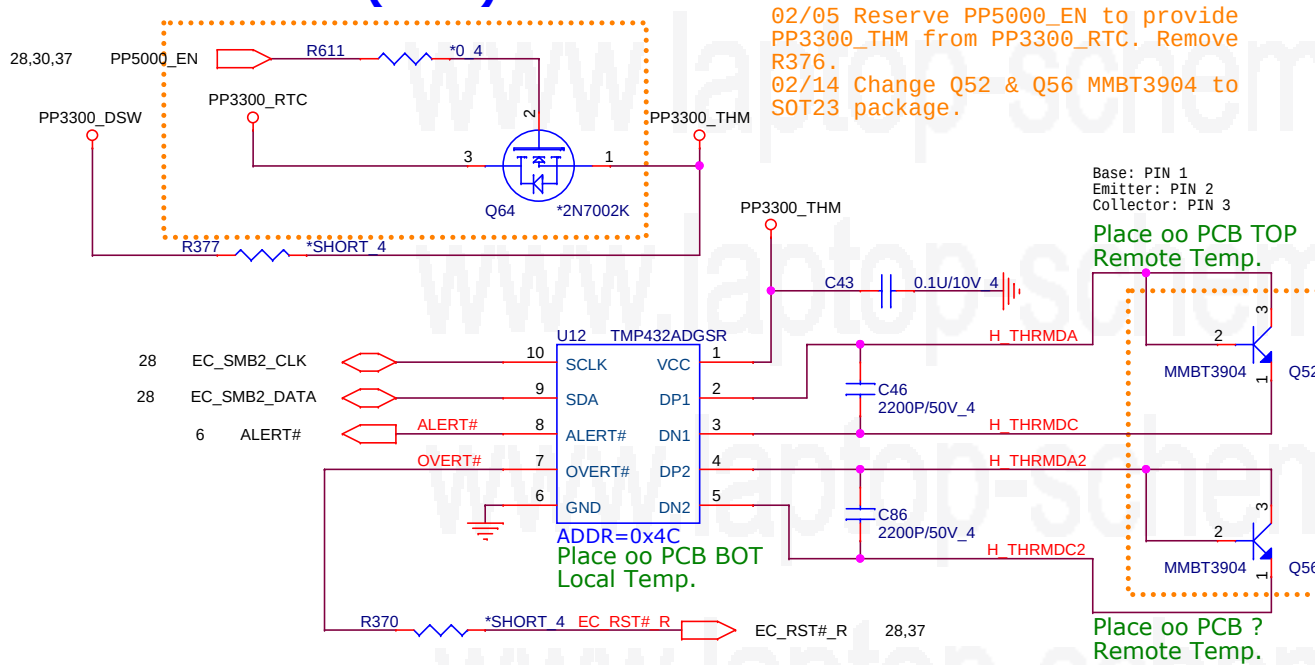


Quanta Computer Inc.

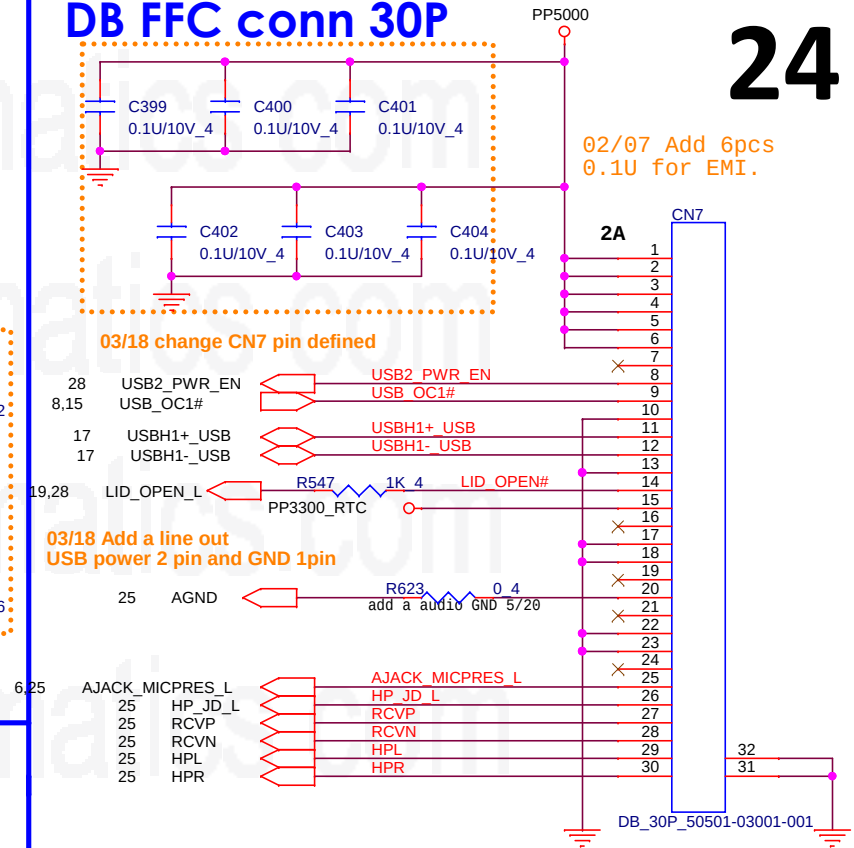
PROJECT : ZHQ

Size	Document Number	Rev
	TPM SLB9655 / LED	1A
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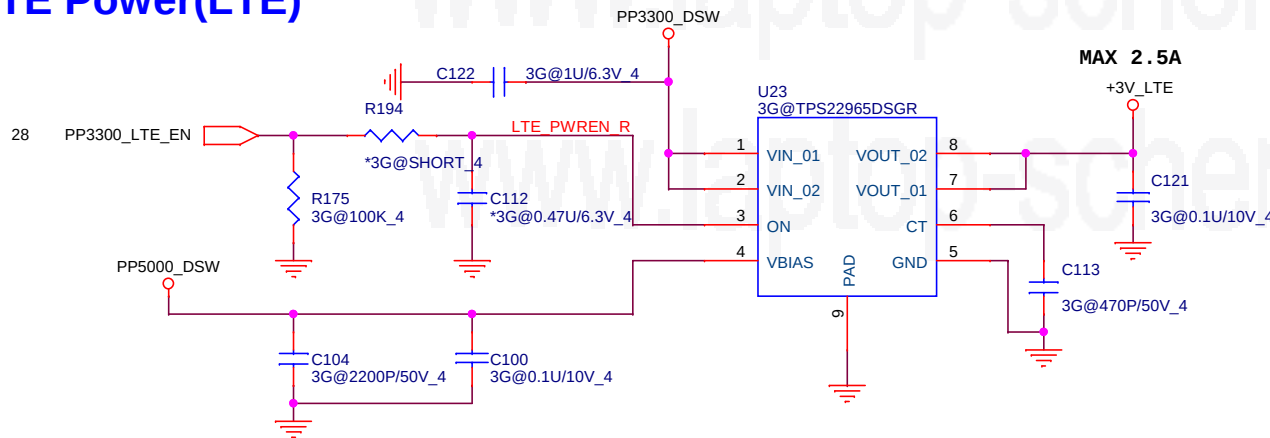
Thermal Sensor(THM)



DB FFC conn 30P



LTE Power(LTE)



USB 2.0_ILIM_SEL (USB)

01/28 remove USB ILIM SEL.



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PROJECT : ZHQ

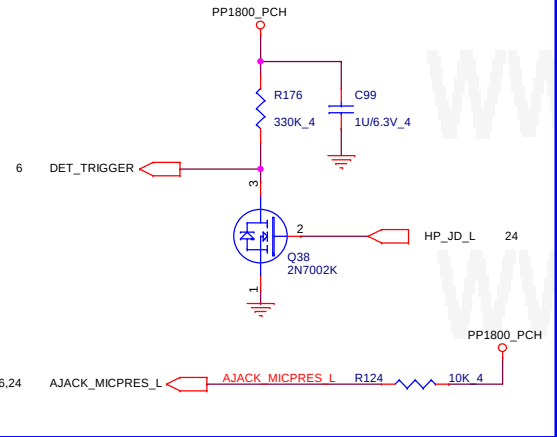
Size	Document Number	Rev
	DB/Thermal sensor/LTE PWR	1A

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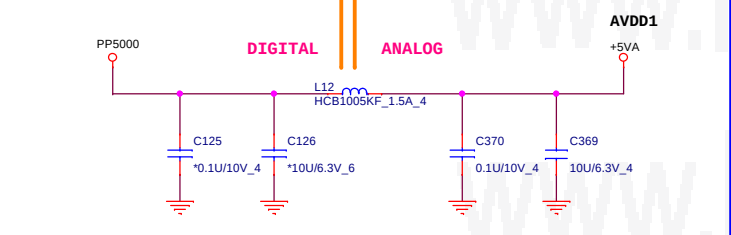
AUDIO CODEC (ADO)

25

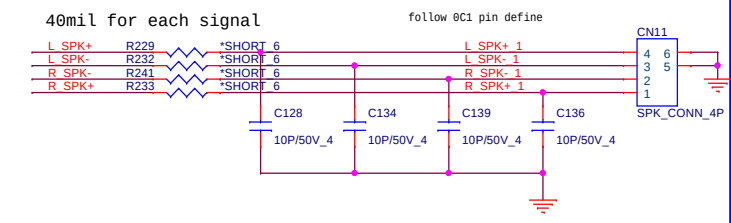
SOC DET (ADO)



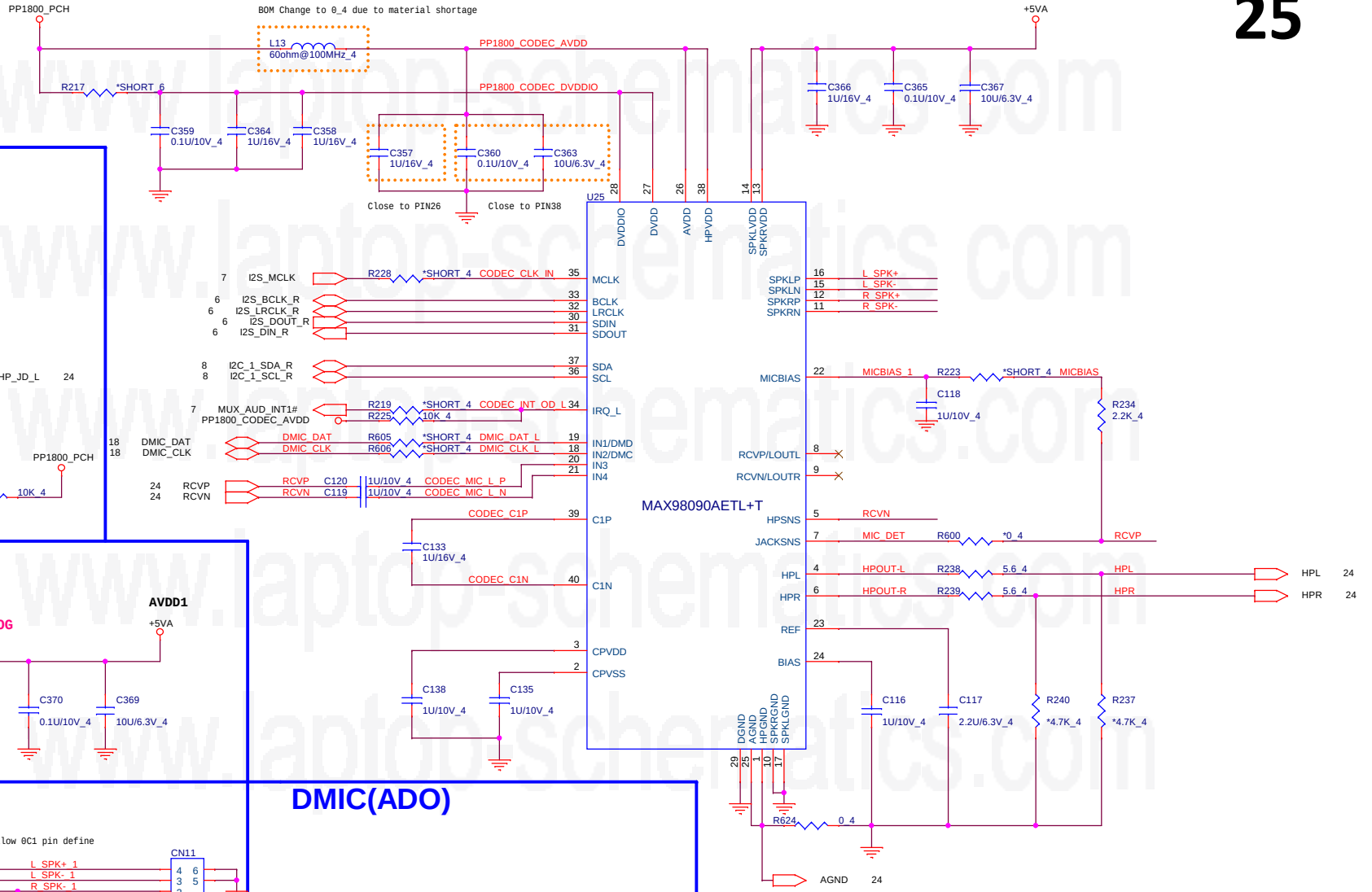
Codec PWR 5V (ADO)



Internal Speaker (ADO)

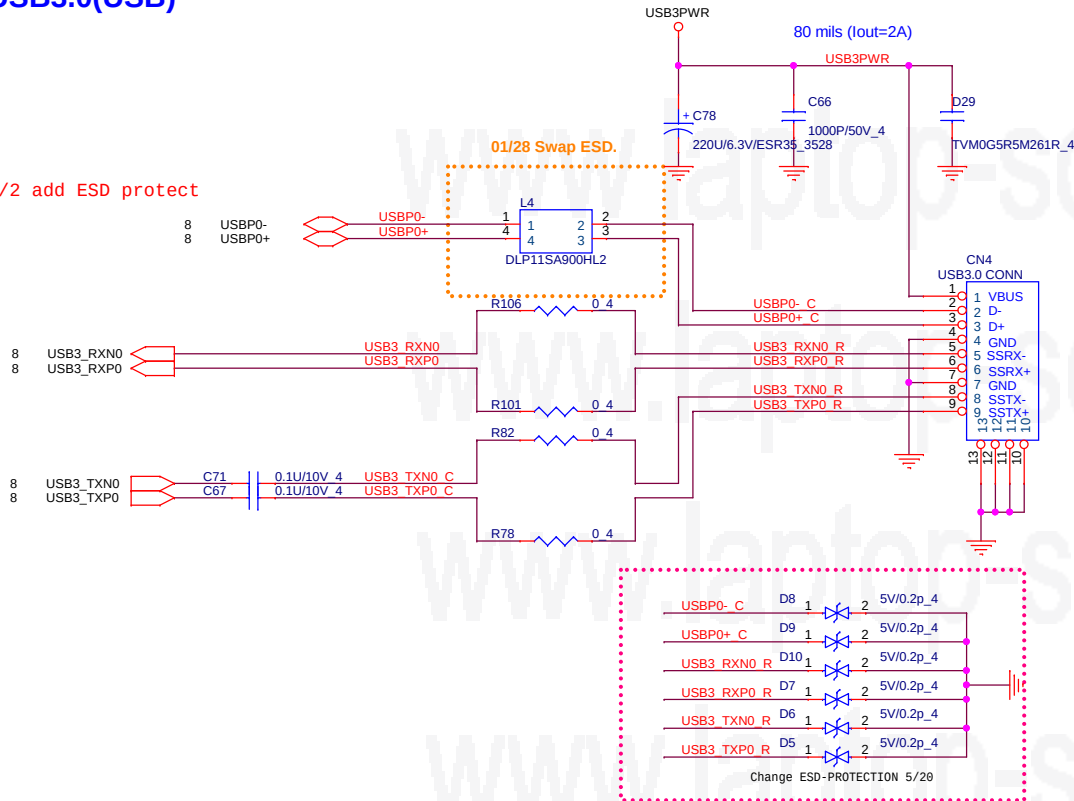


DMIC(ADO)



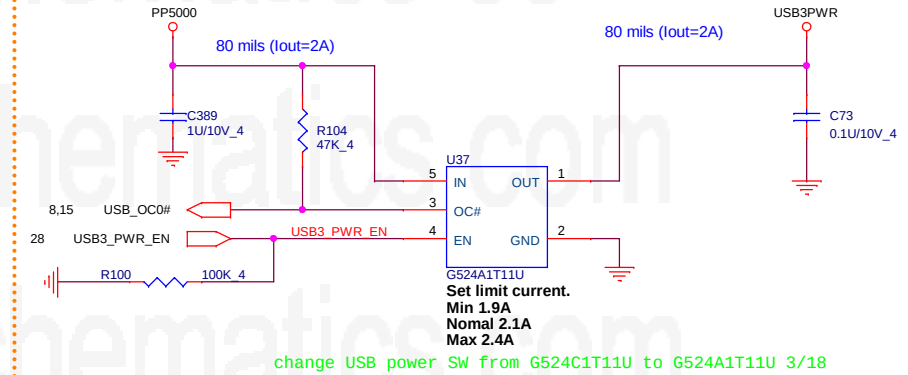
USB3.0(USB)

1/2 add ESD protect



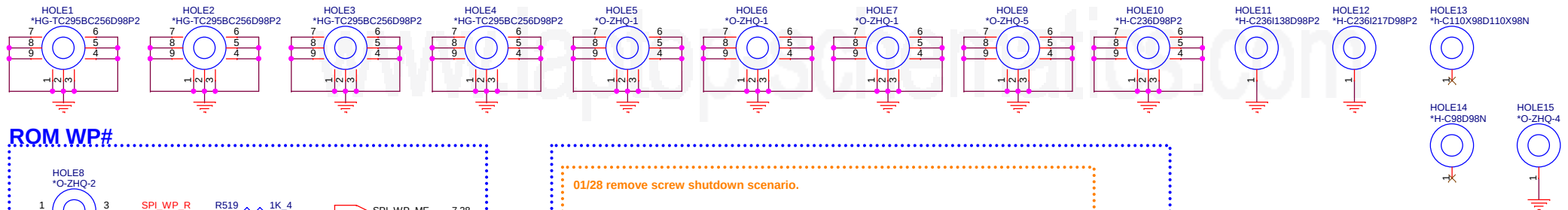
USB Switch

01/28 Change USB power chagreg to power switch.
Need update footprint.
02/11 Change USB power switch (U37) from G547F1P81U to G524C1T11U.

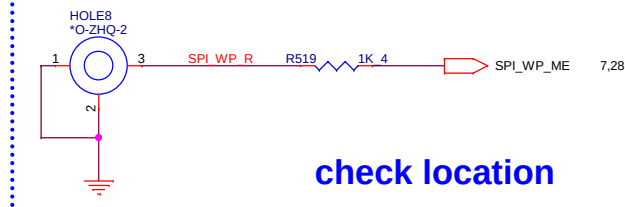


HOLE(OTH)

02/13 Update hole footprint.



ROM WP#



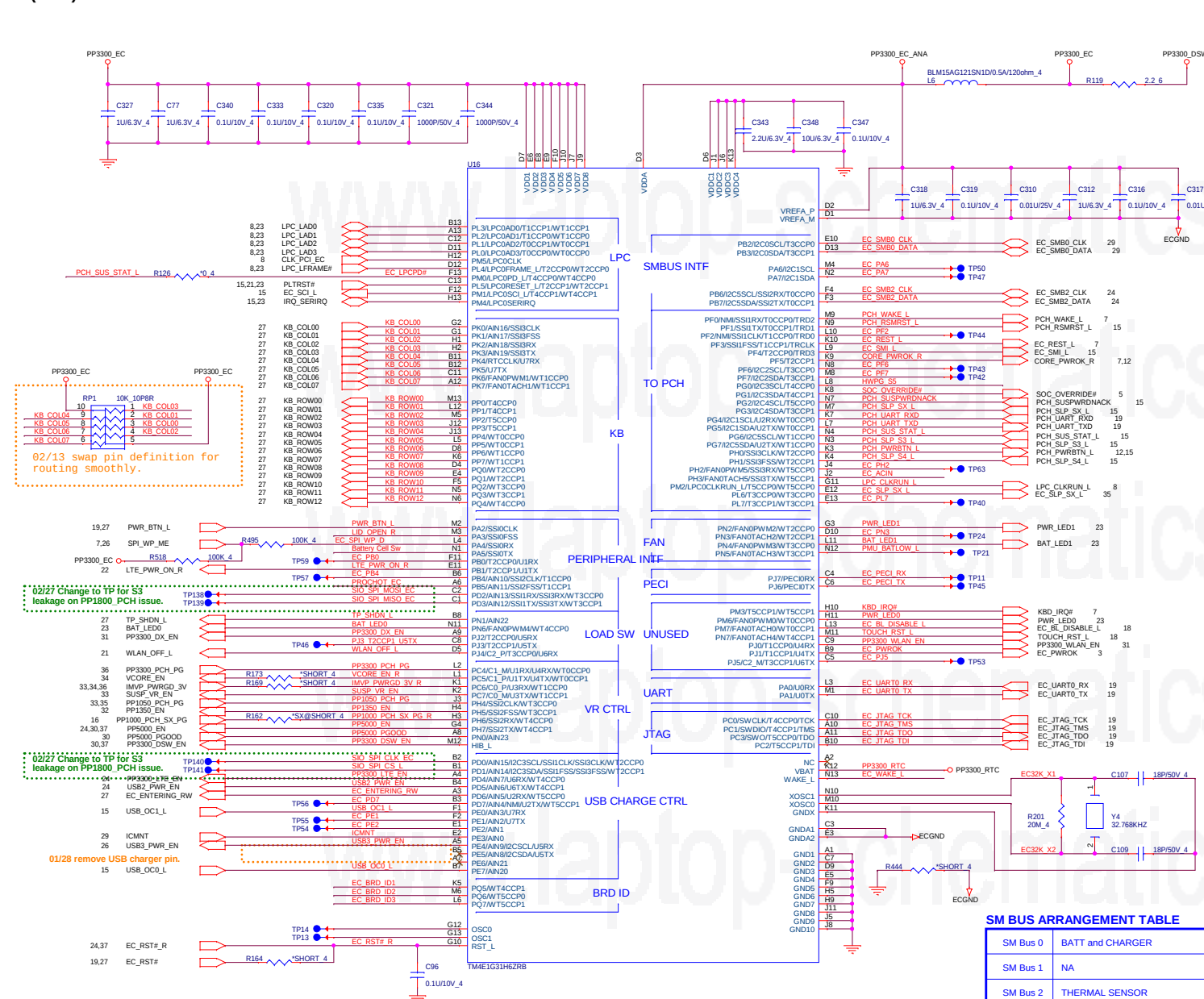
01/28 remove screw shutdown scenario.



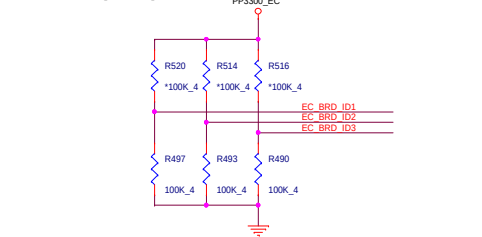
Quanta Computer Inc.
PROJECT : ZHQ

Size	Document Number	Rev
	USB3/Hole	1A
Date:	Thursday, July 03, 2014	Sheet 26 of 42

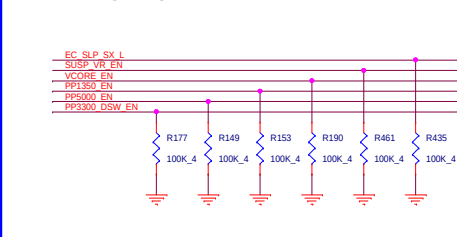
EC(KBC)



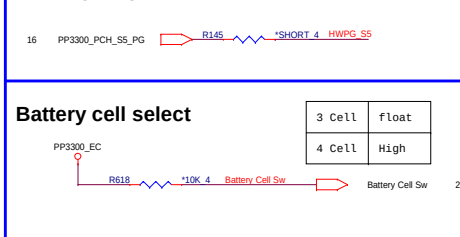
Board_ID(KBC)



Pull-down(KBC)

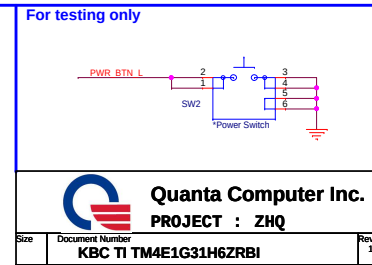


HWPG(KBC)

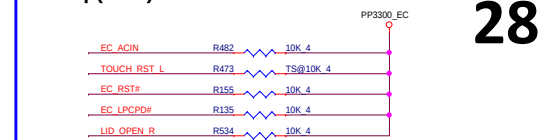


OD pin list	
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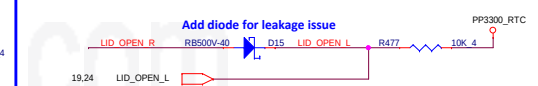
EC_REST_L
BAT_LED0
BAT_LED1
PCH_RSMRST_L
SMBUS
IRQ_SERIRQ
EC_BL_DISABLE_L



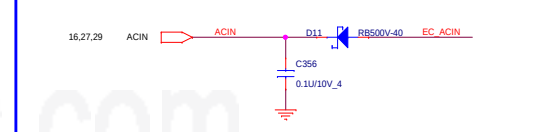
Pull-up(KBC)



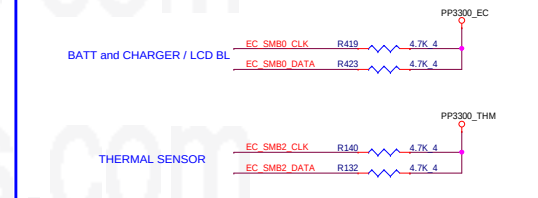
LID_OPEN(KBC)



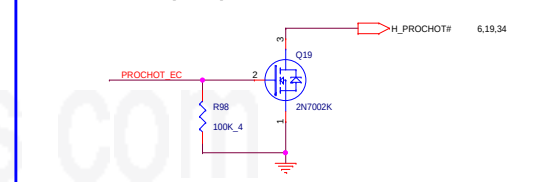
ACIN_EC(KBC)



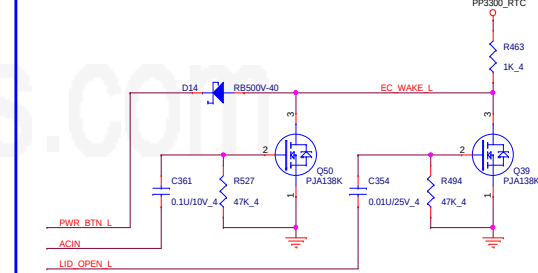
SM BUS/I2C PU(KBC)

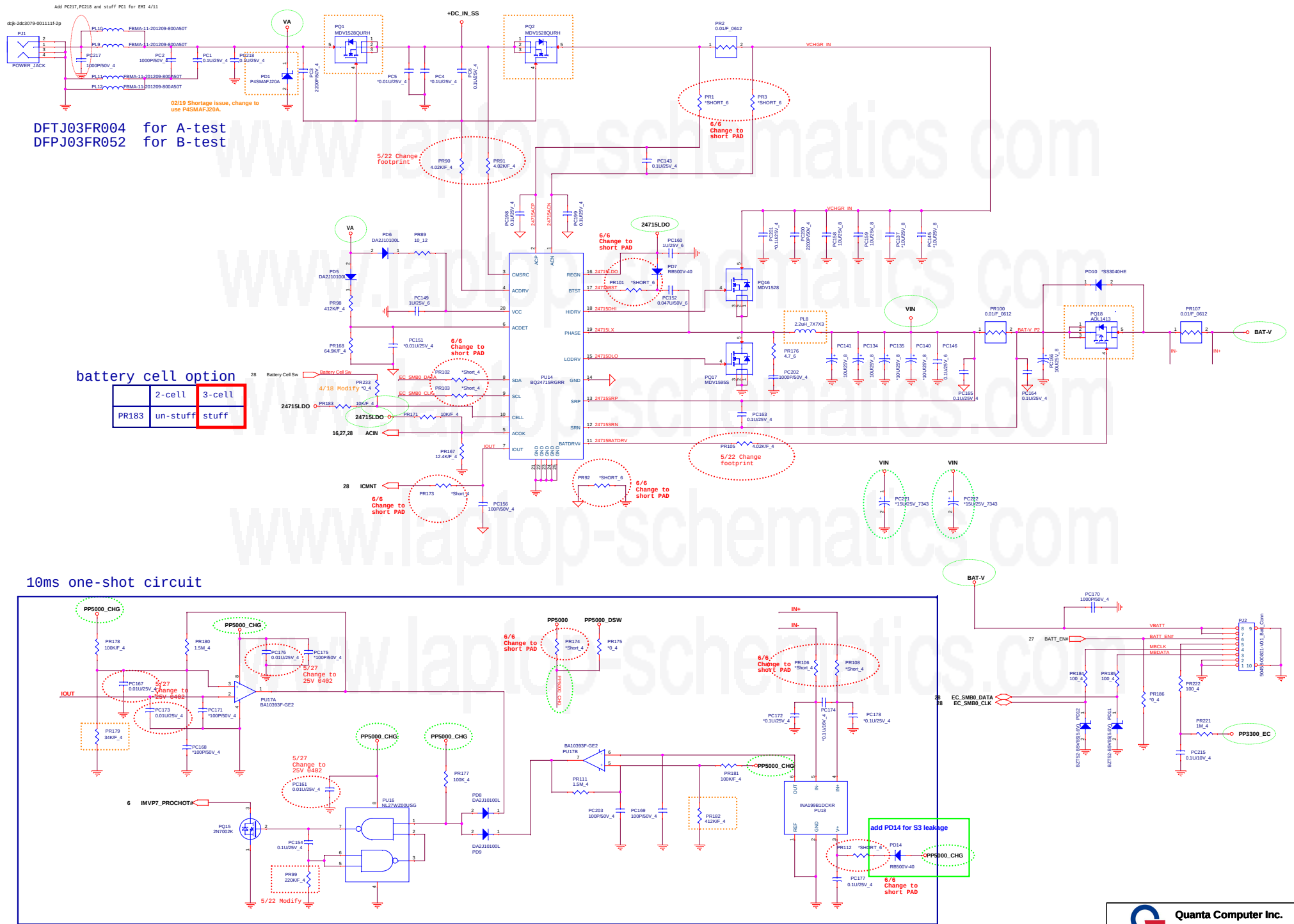


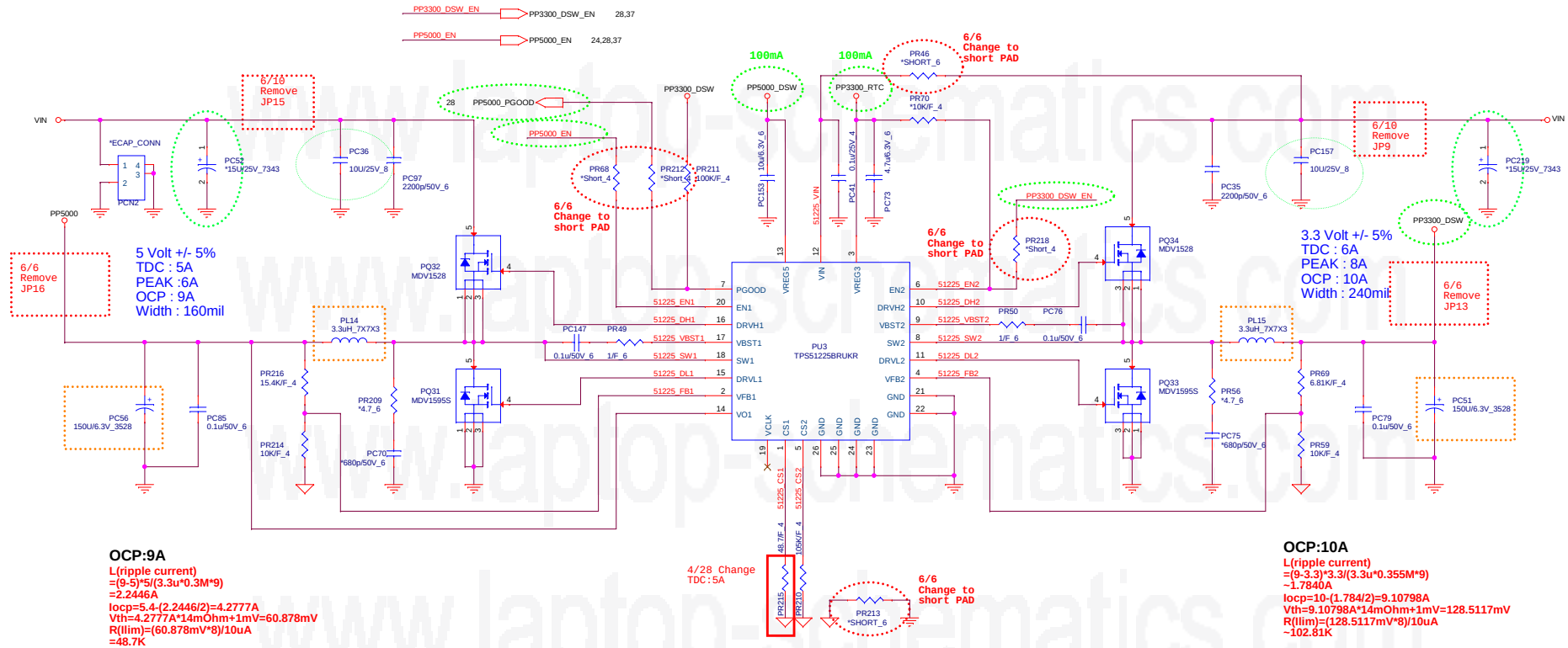
PROCHOT_EC(KBC)



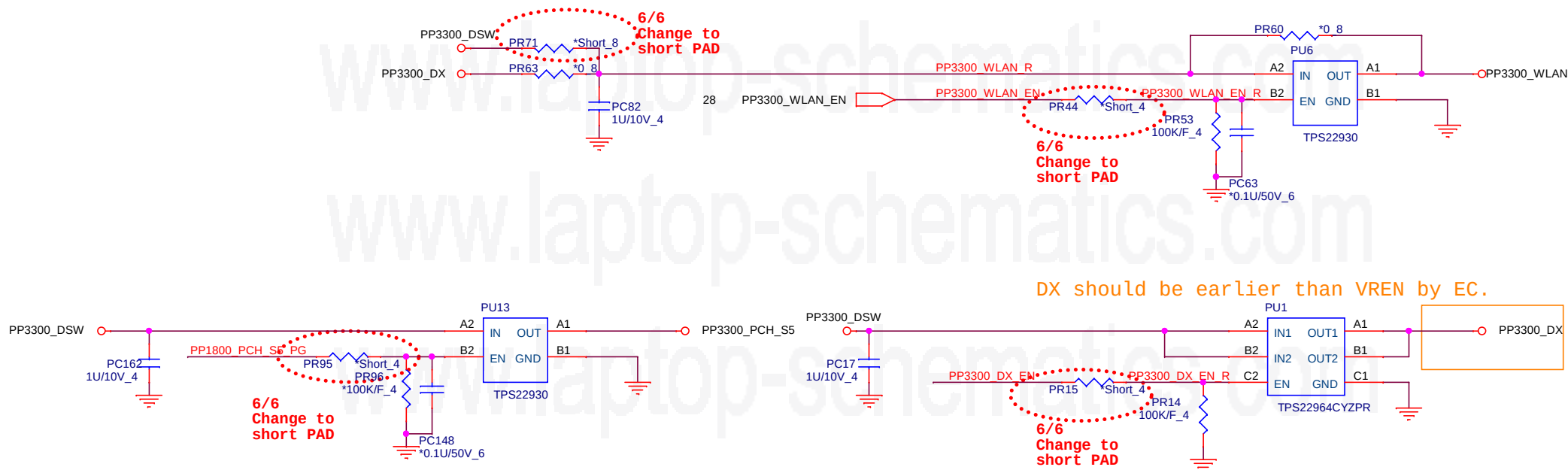
EC HIB WAKE SOURCES







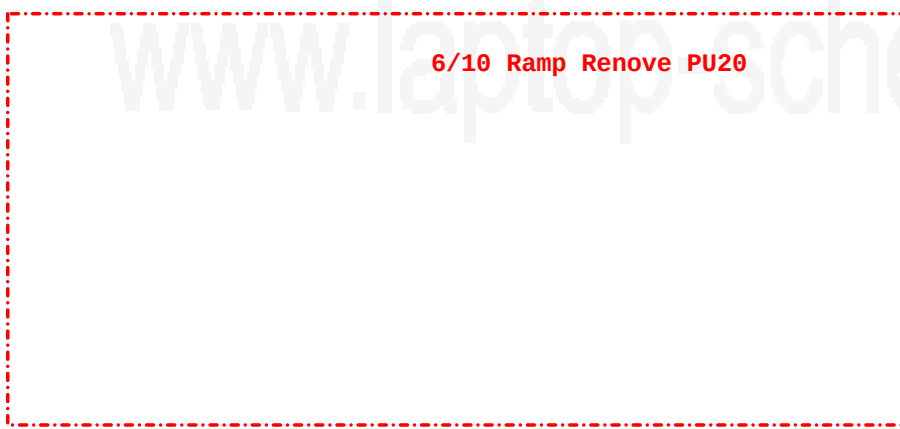
36 PP1800_PCH_S5_PG PP1800_PCH_S5_PG
 28 PP3300_DX_EN PP3300_DX_EN

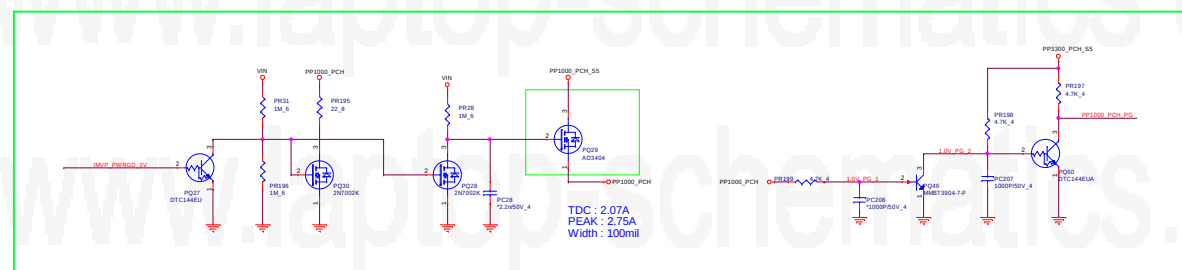
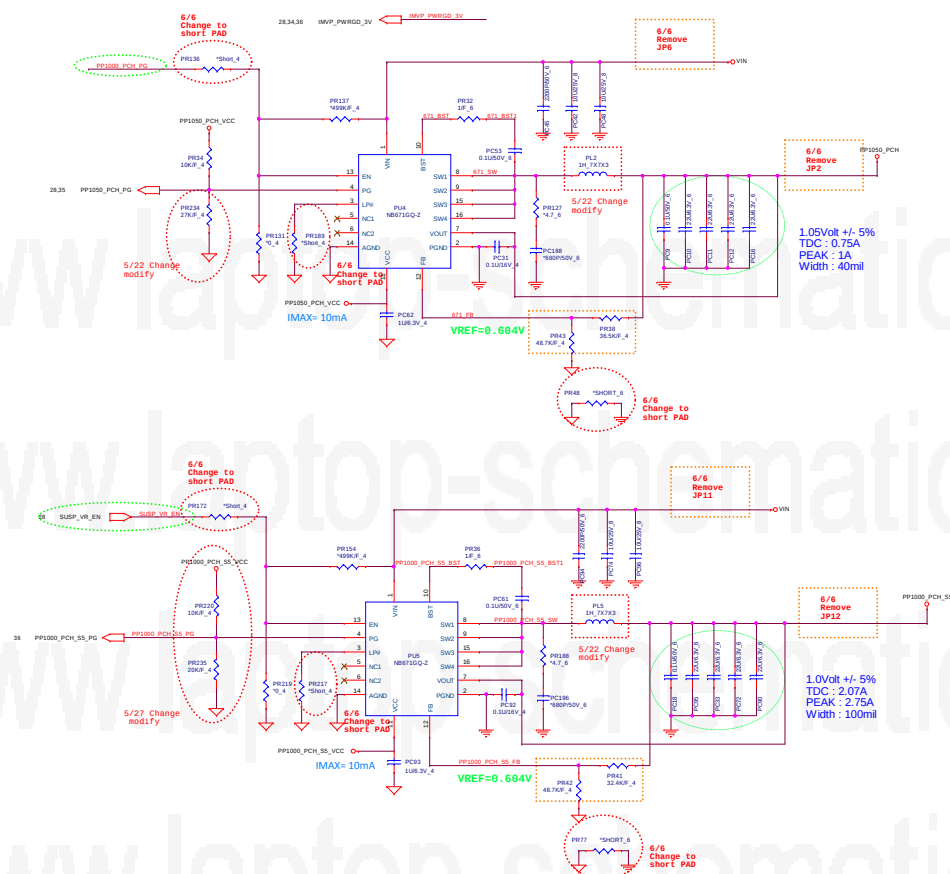


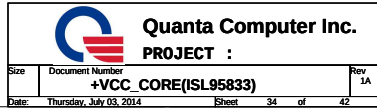
Quanta Computer Inc.

PROJECT :

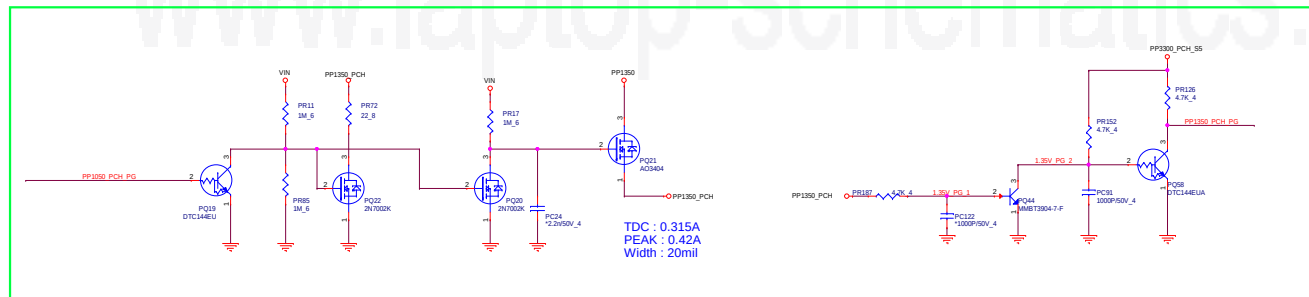
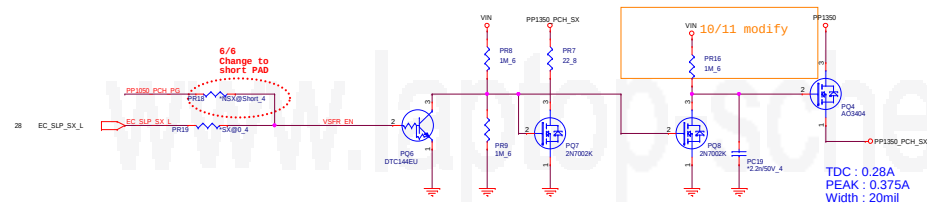
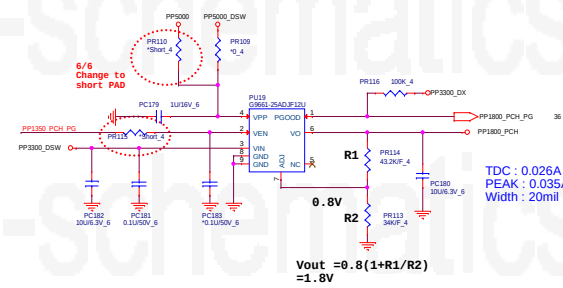
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	Load Switch	1A
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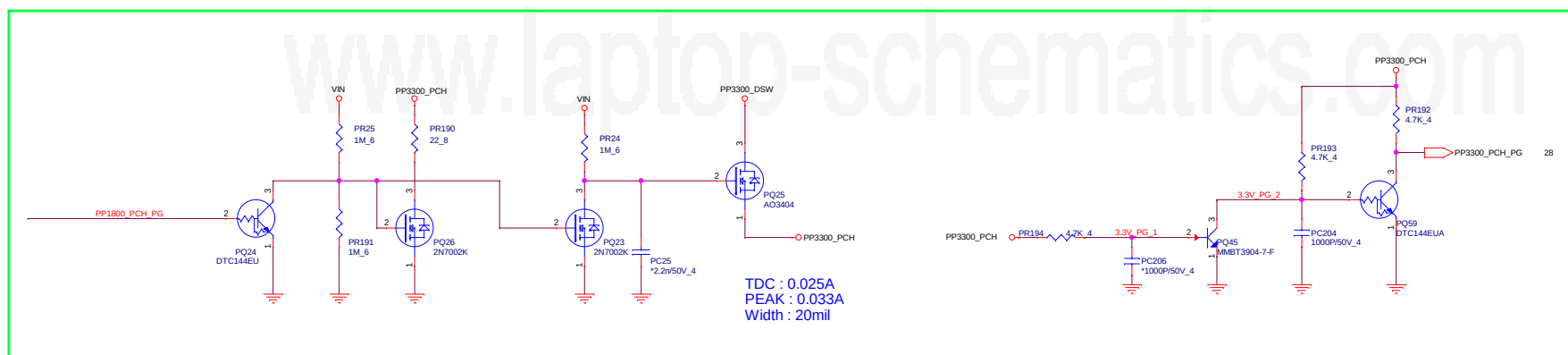
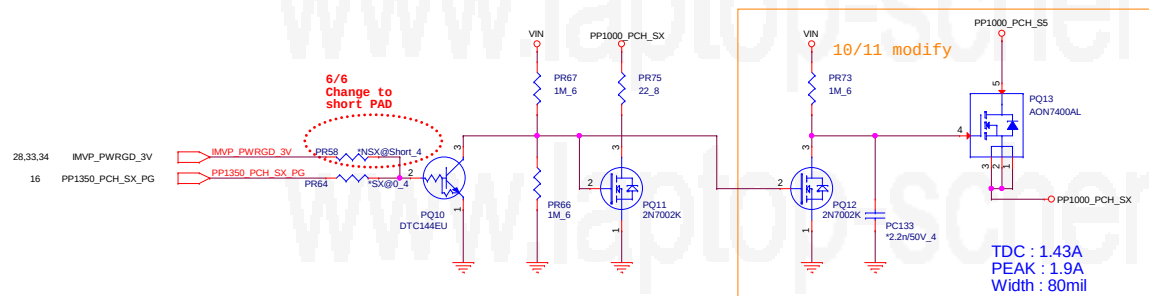
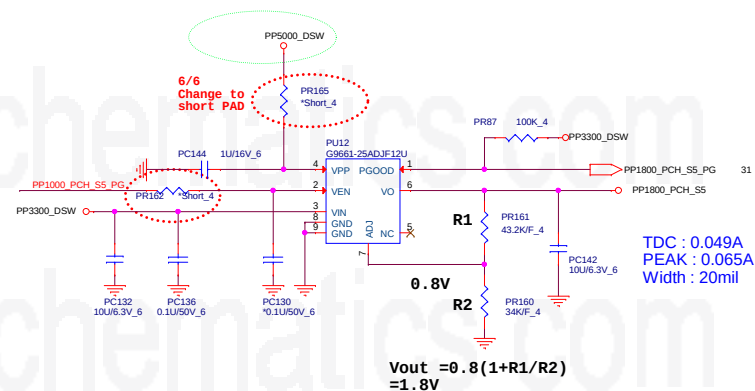




32 VSPR_EN
28.33 SUSP_VR_EN
28.33 PP1300_PCH_PG



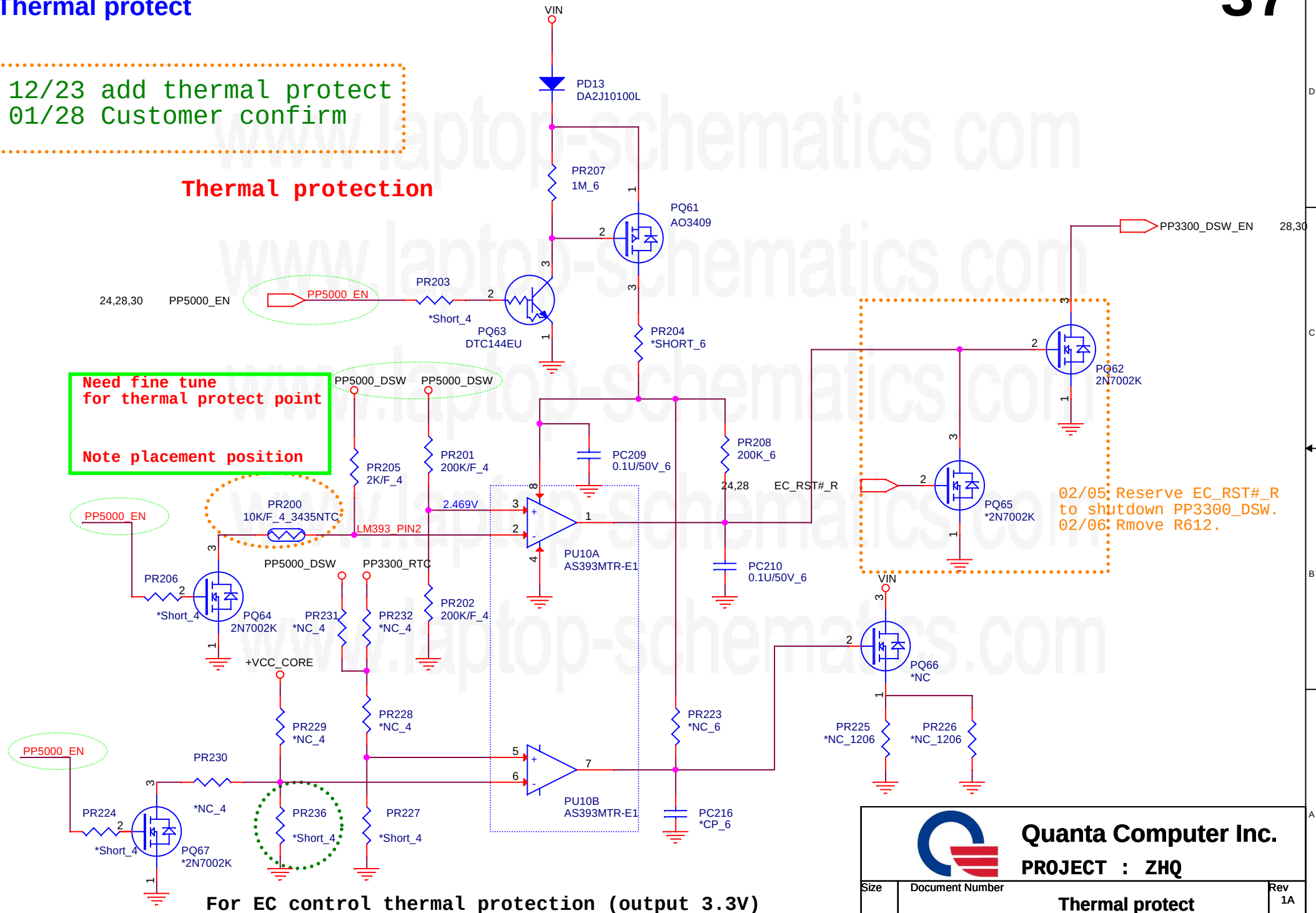
35 PP1800_PCH_PG
33 PP1000_PCH_S5_PG



Thermal protect

12/23 add thermal protect
01/28 Customer confirm

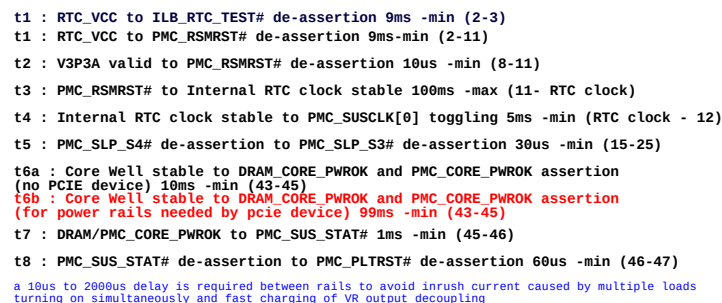
Thermal protection



Quanta Computer Inc.

PROJECT : ZHQ

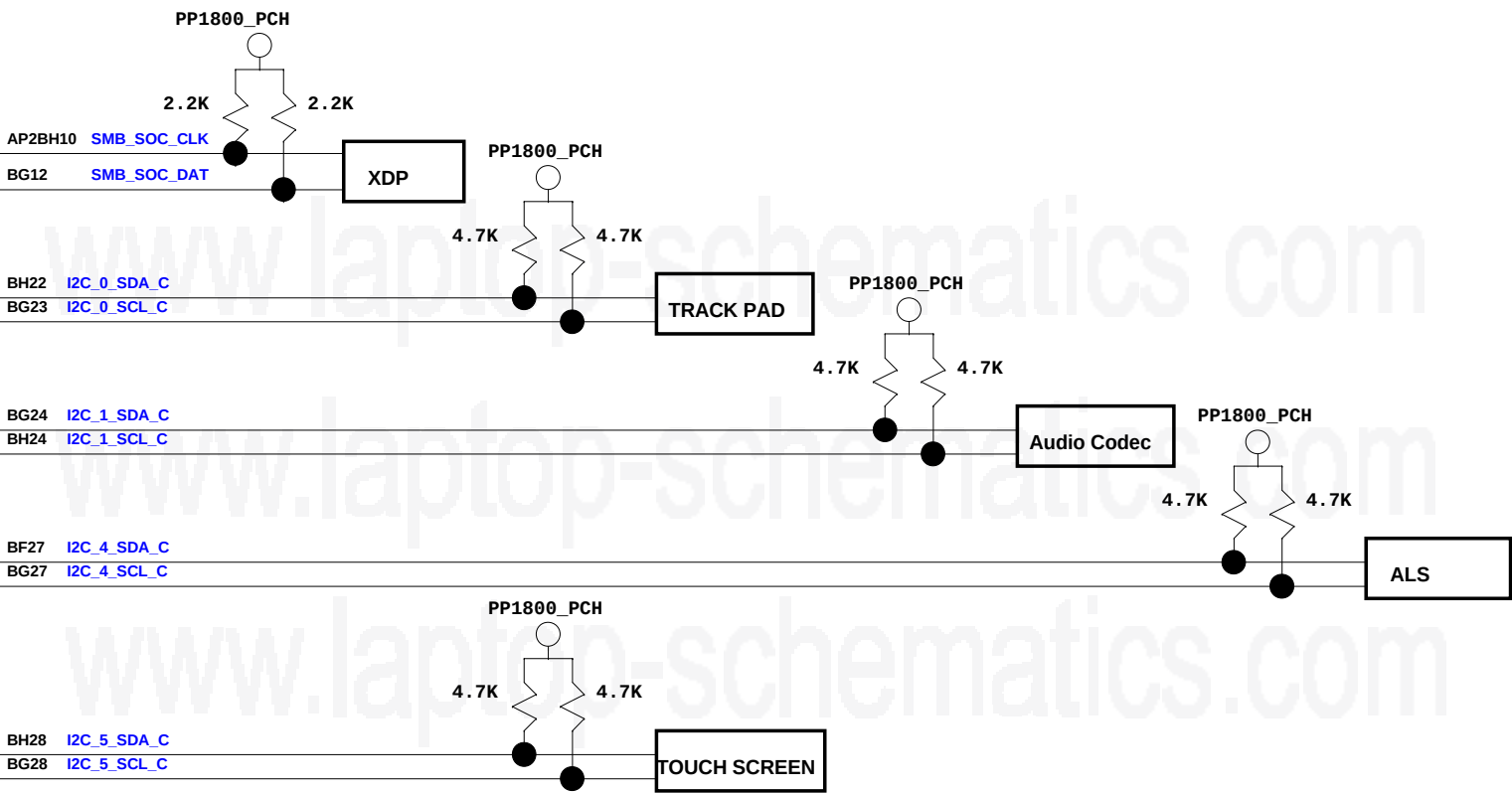
Size	Document Number	Thermal protect	Rev 1A
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SMBUS

Bay-trail M

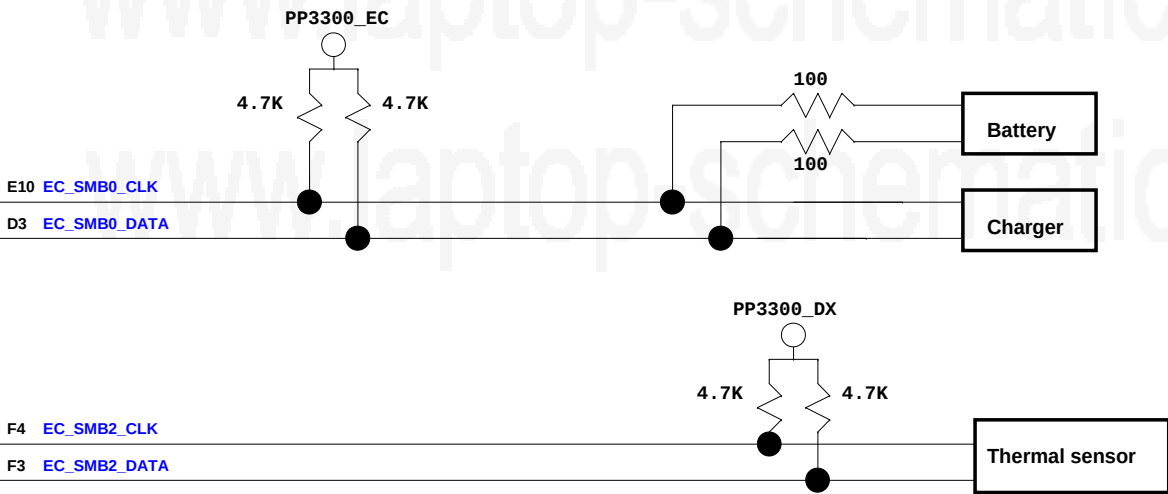
I2C



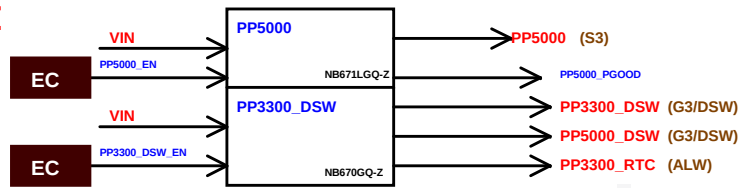
KBC

TI

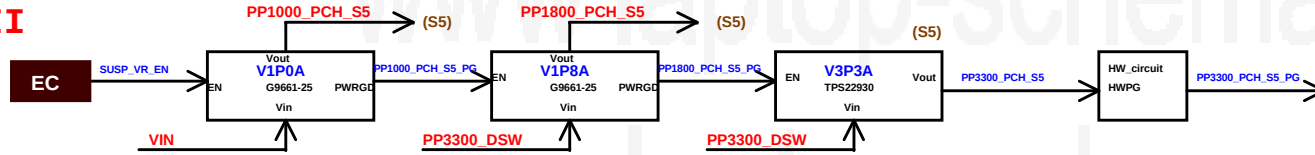
SMBUS



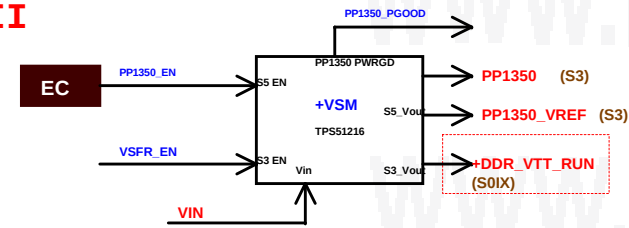
I



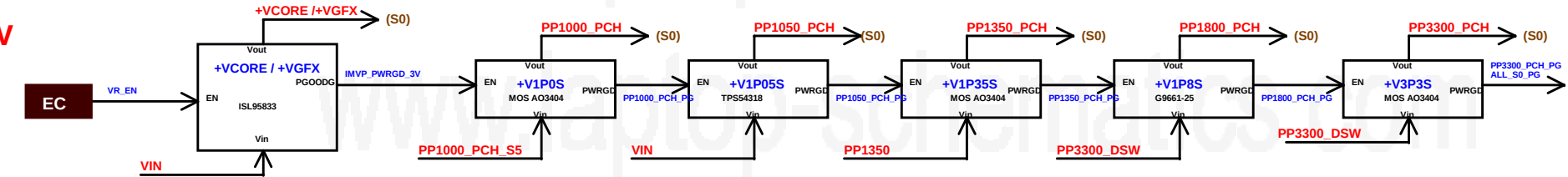
II



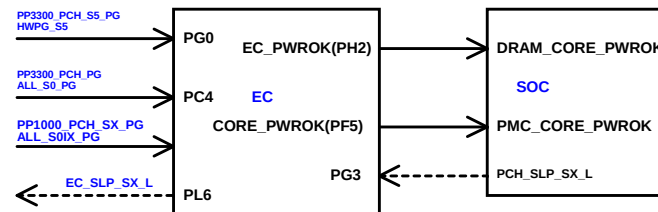
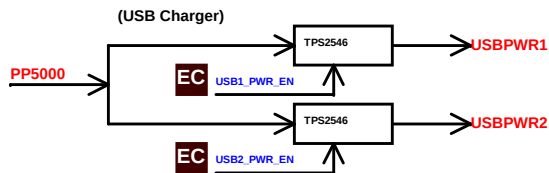
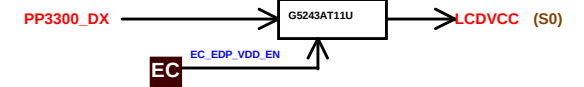
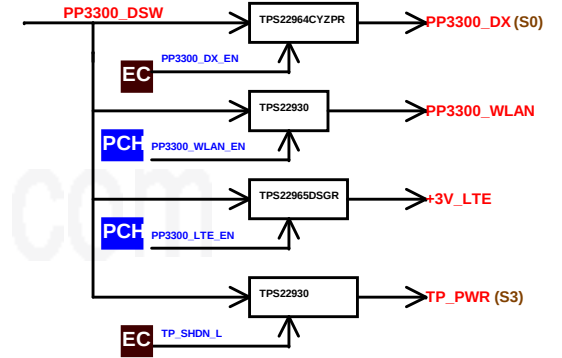
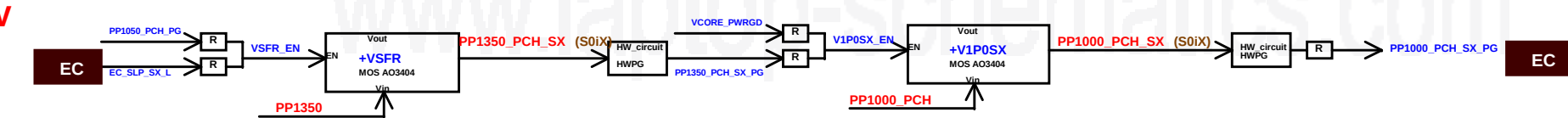
III



IV



V



Model		Version	CHANGE LIST		
		1A	12/23 1.(page37) add thermal protect 2.(page34) remove JP9,JP13 12/24 1.(page27) change keyboard pin define. 2.(page3) change C182 from 0.1u to 1u 3.(page27) change keyboard connector from 36pin to 24pin 12/25 1.(page27) change CN18 from 6pin to 8pin and TP pin define 2.(page27) change PQ268 to R1518 3.(page29) change charger solution from bq24715 to bq24717 4. change PL1-PL8 from 7X7X1.8 choke to 7X7X3 12/26 1.(page 7,22) change R590 to R150 and R150 to R590 2.(page27) add TP111 and TP112 reserve for TP PS2 3.(page24) remove PP3300_PCH_S5 and PP3300_DX on CN7 12/27 1.(page37) change R168 to DNP 2.(page26) change battery cut off switch SW1 from DHPATE2CK03 to DHPH0TEPV00 3.(page26) change USB3.0 connector CN4 from DFFC38FR120 to DFH09WR234 4.(page27) change TP connector CN19 from DFFC08FR060 to DFFC08FR026 12/31 1.(PAGE25) CHANGE DMIC POWER FROM PP1800_PCH TO PP3300_PCH 1/2 1.(page26) add ESD U35 and U36 for USB3.0 1/3 1.(page28) change HDMI connector from 6FH019W8343 to DFH519FR106 1/28 1.(page37) Confirm use Thermal protect. 2.(page26) Change to use USB power switch 6547F1P81U. Reserve TI ESD solution and remove VARISTOR ESD. 3.(page26) Swap U36 and L4 D+/D- for routing. 4.(page28) Remove RMC USB_IL1M_SEL(Pin B6) & Charger Status(Pin A7) and page24 USB 2.0_IL1M_SEL. 5.(page24) Remove FFC USB power charger pin. 6.(page26) Remove screw shutdown scenario. 7.(page27) Add R1 shutdown function. 2/65 1.(page27) Change keyboard ESD pin define for routing. 2.(page21) Per Customer's requirement, Remove GPIO & reserve TP and add TP on WIFI SIO10. 3.(page22) Per Customer's requirement, add TP on LTE Body5A9, LED, Config_1 and GPS disable. 4.(page22) Per Customer's requirement, add TP on LTE Pin 40, 42, 44, 47. 5.(page22) Reserve GPIO from EC to control LTE POWER ON/OFF. 6.(page22) Change C23 to 0.1u. 7.(page37) Reserve EC_RSTN_B to thermal shutdown PP3300_DSM. 8.(page24) Reserve PP5000_EN to provide PP3300_THM from PP3300_RTC. 9.(page24) Remove PP3300_DSM & PP3300_PCH_S5 & PP3300_DX because DB won't use it. 2/66 1.(page24) Remove R376. 2.(page37) Remove R612. 3.(page22) Stuff R25 & R26 & R75. Reserve 33p on U2N_VFP for EMI. 4.(page18) Reserve TP for AUD panel pin 14(LCD Panel Self Test Enable). 2/67 1.(page18) Add 7pcs 0.1u for EMI. Location: C392-C398 2.(page24) Add 5pcs 0.1u for EMI. Location: C399-C404 3.(page27) Swap TP pin definition. 4.(page34) Add 4pcs 0.1u for EMI. Location: PC211-PC214 2/11 1.(page 11) Modify function code to EMC for ESD/EMI. 2.(page 11) Correct all items QFN & Q description. 3.(page 11) Correct Power items QFN that include PU17 & PQ13 & PL1-PL18 . 4.(page 26) Change USB power switch (U37) from 6547F1P81U to 6524C1T11U. 2/13 1.(page 26) Update USB3.0 connector & Hole footprint. 2.(page 28) Swap pin definition for routing smoothly. 2/14 1.(page 24) Change Q52 & Q56 MMBT3904 to SOT23 package. 2/15 1.(page 08) Change RM10 to 081. 2.(page 29) Shortage issue, change to use P43M4F220A.		
		2A	2/27 1.(page 17) Change SD card to half card socket for ME request. 2.(page 34) Core/GFX efficiency improvement. PL4 and PL7 change from 0.24uH to 0.47uH. PR30 and PR62 change from 2.2ohm to 6ohm. PR130 change from 21kOhm to 12kOhm. 3.(page 7 & page 15 & page 28) S3 leakage on PP1800_PCH. Change SIO_SPI_CS#, SIO_SPI_MISO, SIO_SPI_MOSI, SIO_SPI_CLK to TP on page 7, cancel level shift on page 15 and change SIO_SPI_MOSI_EC, SIO_SPI_MISO_EC, SIO_SPI_CLK_EC and SIO_SPI_CS_L to TP on page 28. 4.(page 29) Cancel PR612 and Add one diode R860W-4 for S3 leakage on PP6000 issue. 5.(page 26) Un-stuff PR618 for 3-cell battery. 6.(page 8) Reserve RAM_103 for memory BOM option. 7.(page 27) SL6 Reset IC needs to change new version, wait for confirm. 8.(page 23) Stuff C246 for RF.		
		2B	3/19 1.(page 15) unstuff U26/R391/R502/R156 2.(page 17) Change SD card to full card socket for ME request. 3.(page 24) change CN7 pin defined_Add 2nd headphone and add USB power/gnd pin 4.(page 25) Add 2nd headphone for Education 5.(page 26) change USB Power SW U37 from 6524C1T11U to 6524A1T11U 6.(page 29-37) update power circuit 3/20 1.(page 28) Add PWR_LED1 pin on U16 G3 pin 2.(page 28) Add LITE_PWR_EN pin on U16 E11 pin for LTE power on 3.(page 28) Add Battery cell select pin on U16 W1 pin for 3S/4S select 3/25 1.(page 18) CHANGE POWER FROM PP1800_PCH TO PP3300_PCH and add R619/R620 2.(page 18) C284, C287, C395, C313, C296, C339, C349, C314, C306 *9pcs change from CHS181K0801(1u) to CHS181M0802(18u) 3.(page 18) C207, C266, C363, C288, C247, C246, C253, C259, C262, C254, C258, C255, C256, C295, C309, C261, C264, C267 *18pcs change from CHS181K0801(1u) to CHS181M0802(18u) 4.(page 29-37) update power circuit 3/31 1.(page 8) CHANGE DRAM ID table 2.(page 23) CHANGE LED to BL/ORG 4/62 1.(page 25) Remove DMIC onboard circuit 2.(page 18) Add DMIC pin at LVDS connector 4/63 1.(page 25) Remove 2nd headphone for Education 4/11 1.(page 29) Add PC217,PC218 and stuff PC1 for EMI 2.(page 26) nusuff R93,R87 and stuff L4 for EMI 3.(page 17) Add C405 and C406 for SIO2 3G card 4/11 4/18 1.(page 22) CNS cahgne footprint from NGFF-88149-2121-75P-KB-SMT to NGFF-80149-2121-75P-KB 2.(page 29) Add PR623 for Battery Cell Sw 3.(page 27) Change U34 from AL822908000 to AL822902T00 for cost down 4/21 1.(page 17) C06/C07 change to 22p for crystal report 4/23 1.(page A11) Correct BOM 2.(page 27) Change R546 location and add Q44/Q65 on Track Pad INTn for leakage issue follow 6C9 3.(page 18) Add C487 on Touch Reset line for power sequence 4.(page 34) change PCR7,PCR8,PC119,PC126 to 18uF follow 6C9		
DOC NO.	PROJECT MODEL :	Chome	APPROVED BY:	DATE:	 Quanta Computer Inc. PROJECT : 220 Change list
	PART NUMBER:		DRAWING BY:	REVISION:	

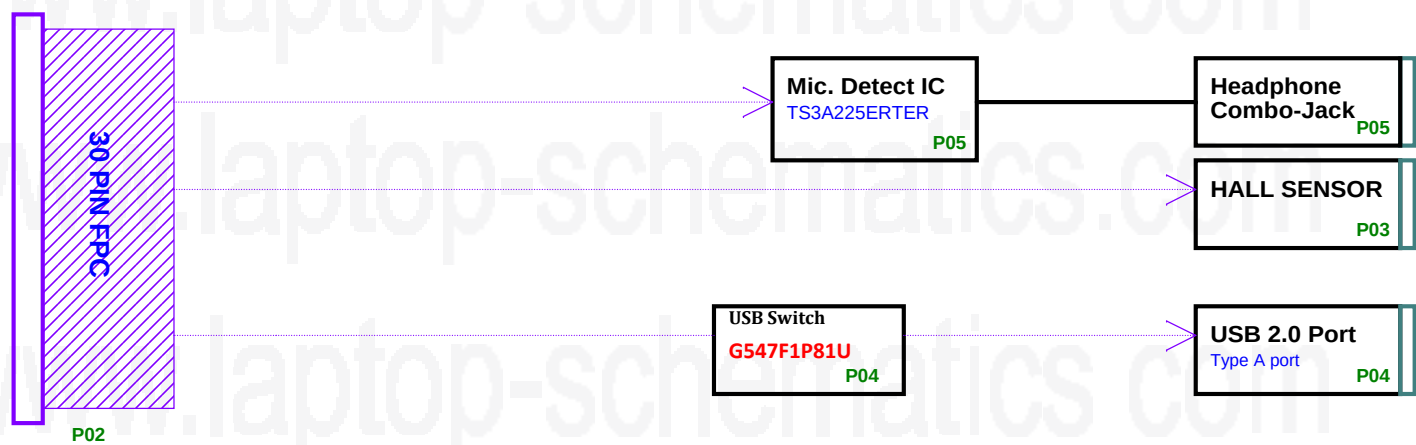
Model		Version	CHANGE LIST		41		
		2B	4/23	6.(page 31) Change PC29/PC13 to 18uF Follow 0C9 7.(page 31) PC24 change to 0.1u 8.(page 27) Change R144 from 4.7K to 1M and add a cap C352 2.2uF for Battery shipping mode by SL64350, U17 change to SL64K4350 9.(page 26) Change C78 to 220uF and Add D29 10.(page 7) add C408 on CORE_PWR0K For ESD Improvement 11.(page 6) add C409 on PROCHOTa For ESD Improvement 12.(page 3) C102 to be changed to 0.1uF on DWRP_PWR0K For ESD Improvement			
			4/24	1.(page 8) reserve R403 for CLAUDINE disable follow 0C9 2.(page 27) stuff U30,U31,U32,U33,U34 for ESD 3.(page 30) change PC36 to 18uF			
		3C	5/13	1.(page 16) Modify level shift circuit for TPS and BOM changed			
		5/20	1.(page 26) change ESD-PROTECTION and remove U35/U36 circuit 2.(page 24) Change DB pin defined and add a audio GND for audio issue				
			5/22	1.(page 25) Add R625 for Audio Issue 2.(page 24) Change CN7 pin 29 connect to AGND for audio issue 3.(page 29) update power schematic 4.(page 33) update power schematic for power sequence			
		5/23	1.(page 33) Change PR234 from 20K to 27K and Correct PR235 AGND 2.(page A11) Correct BOM				
		5/26	1.(page 29) Change P22 connector from DFH0808M5125 to DFH0808M201 2.(page 8) Add R625 and R626 for TPS Issue				
		5/29	1.(page 23) Exchange LED1 and LED2 for icon issue 2.(page 23) change R509,R509,R246,R245 for LED Light				
		3D	6/3	1.(page 26) L4 change P/N from CX008HL2009 to CX008HL2002 2.(page 34) unstuff PC60 and PC139 for cost down			
		6/6	1.(page 28) change EC P/N to AR02Q051001 for T11 issue 2.(page 3) change R178/R335 to 0402 shortpad for cost down 3.(page 5) change R50/R524/R102/R402/R407/R100/R107 to 0402 shortpad for cost down 4.(page 6) change R303/R123/R121/R230/R204/R375/R270/R303/R303/R414/R450/R462 to 0402 shortpad for cost down 5.(page 7) change R81/R107/R133/R424/R440/R468/R470/R471/R470/R481/R513/R105 to 0402 shortpad and R116/R157 change to 0603 shortpad for cost down 6.(page 8) change R109/R440 to 0402 shortpad for cost down 7.(page 9) change R343/R305 to 0402 shortpad for cost down 8.(page 10) change R54/R110/R114/R121/R178/R300/R305/R400/R407/R430/R453/R456/R460/R464 to 0402 shortpad and R193/R555 change to 0603 shortpad,R354/R304 change to 0603 shortpad for cost down 9.(page 12) change R263/R307/R319/R320/R325/R332 to 0402 shortpad and R337 change to 0603 shortpad for cost down 10.(page 15) change R446 to 0402 shortpad for cost down 11.(page 17) change R400/R507/R524/R541/R540/R500/R502 to 0402 shortpad and R330 change to 0603 shortpad for cost down 12.(page 18) change R208/R326/R330/R341/R620 to 0402 shortpad and R14/R224 change to 0603 shortpad,R17 change to 0805 shortpad for cost down 13.(page 19) change R216/R222/R400/R500/R524/R535/R538/R540/R564/R565 to 0402 shortpad for cost down 14.(page 20) change R72/R73/R74 to 0402 shortpad for cost down 15.(page 21) change R44/R46/R55 to 0402 shortpad and R39 change to 0805 shortpad for cost down 16.(page 22) change R75/R411 to 0402 shortpad and R355/R602 change to 0603 shortpad, R601 change to 0805 shortpad for cost down 17.(page 23) change R56/R553 to 0402 shortpad for cost down 18.(page 24) change R370/R377/R194 to 0402 shortpad for cost down 19.(page 25) change R210/R225/R605/R600/R210 to 0402 shortpad and change R217/R220/R232/R233/R241 to 0603 shortpad for cost down 20.(page 27) change R213/R490 to 0402 shortpad and change L7 to 0603 shortpad for cost down 21.(page 28) change R145/R162/R164/R160/R173/R444 to 0402 shortpad for cost down				
		6/9	1.(page 12) unstuff U10 and C16 for cost down 2.(page 29-30) 1.Removed : JP2,JP3,JP7,JP12,JP13,JP14,JP16,JP15,JP9,JP1,JP11,JP6 2.Change to shortpad:4: PR00,PR10,PR105,PR18,PR11,PR10,PR140,PR10,PR147,PR02,PR03,PR143,PR140,PR130,PR109,PR172,PR217,PR05,PR04,PR15,PR00,PR212,PR102,PR103,PR173,PR174,PR100,PR100 3.Change to shortpad:6: PR144,PR00,PR02,PR40,PR77,PR124,PR46,PR213,PR1,PR3,PR103,PR02,PR112 4.Change to shortpad:8: PR71 5.Remove CURRENT POWER MONITOR circuit : PU22,PU11,PU20,PU21,PC191,PC192,PC113,PC131,PC184,PC185,PC189,PC190,PC193,PC194 6.Keep Vin 7343 Capacity: PC219,PC220,PC221,PC222				
		6/16	1.(page 37) PR236 and PR227 change to shortpad 2.(page 27) unstuff SW1/Q02/Q03/0609 for Acer request remove reset function.				
6/17	1.(page 27) modify EC reset circuit and Add D1002 and D1003 for ESD issue.						
			6/23	1.(page 27) change U24 P/N fromAL020902T09 to AL02090800 for SMT issue 2.(page 27) SW1/C306/R027/R020 unstuff for removed RST button 3.(page 18) Remove L1 for SMT request and R8,R9 change to shortpad.4 for cost down. 4.(page 20) Remove L2 for SMT request , R41,R09,R22 change to shortpad.4 for cost down. 5.(page 22) Remove L15 for SMT request. 6.(page 20) Remove L13,L5,R03,R07 for SMT request. 6.(page 34) PR01 change to shortpad.4 for cost down.			
		7/2	1.(page 37) change PR205 from 1.5K to 2K for throne request				
DOC NO.	PROJECT MODEL :	Chrome	APPROVED BY:		DATE:		 Quanta Computer Inc.
	PART NUMBER:		DRAWING BY:		REVISION:		PROJECT : Z00
							Change list3

Model	REV	CHANGE LIST	MODEL	FROM	To		
ZHQ	1A	2013/12/23 1. Release first version for ZHQ. 2. (Page 1)Update CN4 QPN , Footprint and Part Description 3. (Page 1)Remove LED1 and R1,R9 and R2 4. (Page 1) Remove NetName PWR LED0 and PWR LED1 5. (Page 1,2,3) Update Function code 6. (Page 1) Remove R6 ,R7 and AGND	Page 02		1A		
		2014/01/27 1. Change the page number Page 1 -> Page 3 , Page 2 -> Page 4 , Page 3 -> Page 5 , Page 4 -> Page 1 2. (Page 2)Add block diagram	Page 03		1A		
		2014/01/28 1. (Page 3)Remove CN4 ,Pin23, 24, 26 , Add one TP 2. (Page 4)Change USB charger to USB Switch 3. (Page 2)Change Block diagram	Page 04		1A		
		2014/02/03 1. (Page 3)Change CN4 Pin5 pin definition	Page 05		1A		
		2014/02/05 1. (Page 3)Remove CN4 Pin10,11,15					
		2014/02/07 1. (Page 4,5)Change USB2.0/Audio jack connector Part number					
		2014/02/10 1. (Page 3)Change CN4 input current form 1.5A to 2A 2. (Page 3)Base on DXF, remove the Hole7. 3. (Page 4)Change the C2 QPN.					
		2014/02/11 1. (Page 4)Change USB power switch (U1) from G547F1P81U to G524C1T11U. Change C3 value from 1U to 2.2U.					
		2014/02/12 1. (Page 3)Add 0.1u on PP5000 & PP3300_RTC for EMI. 2. (Page 3,4,5) Rename all location					
		2014/02/13 1. (Page 4)Change C1 from CH7101MT05 to CH7101MT202					
		2014/03/07 1. (Page 3) Change pin5 pin definiton from DET_TRIGGER_SW to HP_JD_L for Audio.					
		2014/03/24 1. (page 3) change CN1 pin defined , add USB power/gnd pin for ESD. 2. (page 4) change USB Power SW U2 from G524C1T11U to G524A1T11U for USB.					
		2014/04/03 1. (page 3) Remove CN3 Pin10 ,11 for Acer request					
		2014/04/10 1. (page 4) Remove R9,R10.And change L5 from CX1HN900000 to CX12B900000 for USB.					
		2014/04/14 1. (page 3) Change MR1 from AL008251000 to AL009132003 for Lid.					
		2014/04/23 1. (page 5) Add D7 , Stuff D1,D2,D3,D4 for ESD.					
		2014/05/05 1. (page 5) Separate it between AGND and DGND,Add R36,R37,R26,R38,R52,R53,C24,C23 for Audio					
		2014/05/07 1. (page 3) Separate it between AGND and DGND,Add R54 for Audio					
		2014/05/16 1. (page 5) Separate it between AGND and DGND,Nustuff R37,R26,R38,R52,R53,C24,C23 for Audio					
		2014/05/28 1. (page 5) Nustuff R36 for Audio					
		2014/06/23 1. (page 4) Remove R9,R10 for SMT request					

VER : 1A

BOM P/N	Description
*	ZHQ IO/B ASSY

Block Diagram
(Audio Headset Switch + Phone Jack +
Hall Sensor + USB CONNECTOR)

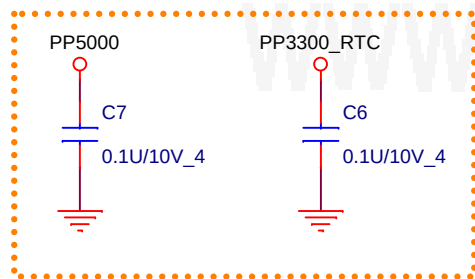
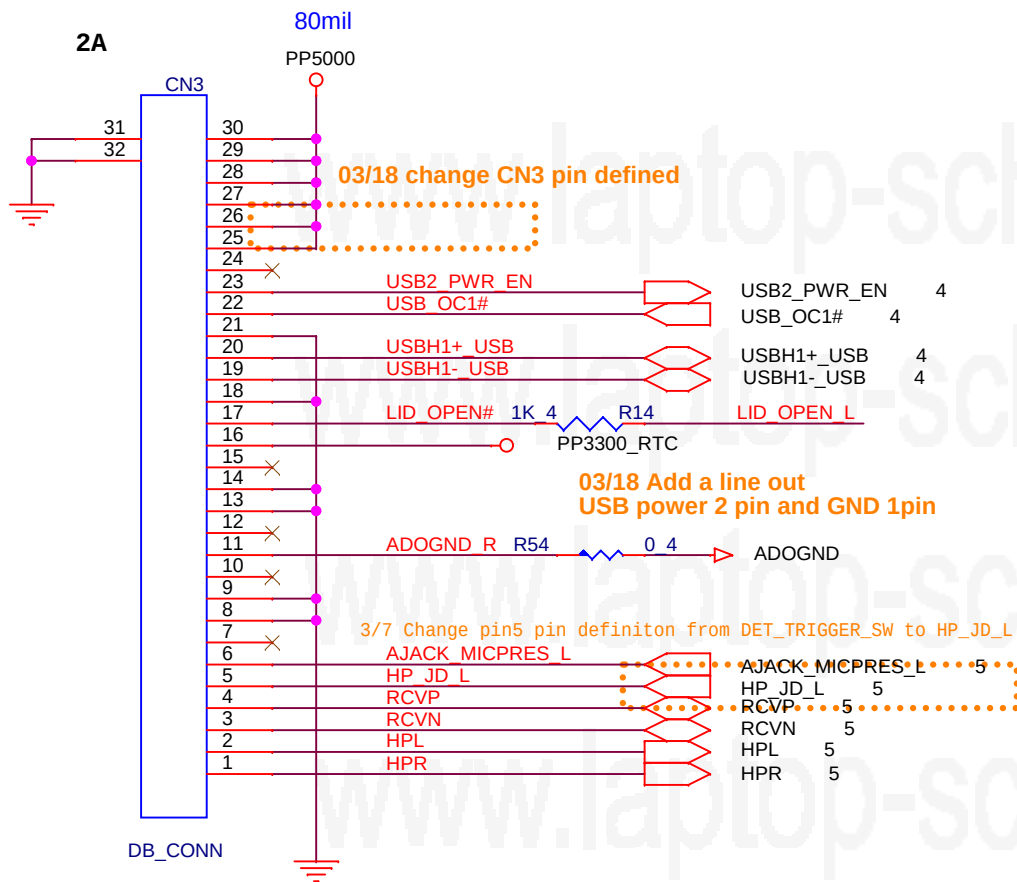


Schematic Marks

Reference	Description
*	do not stuff
/F	1% esistance

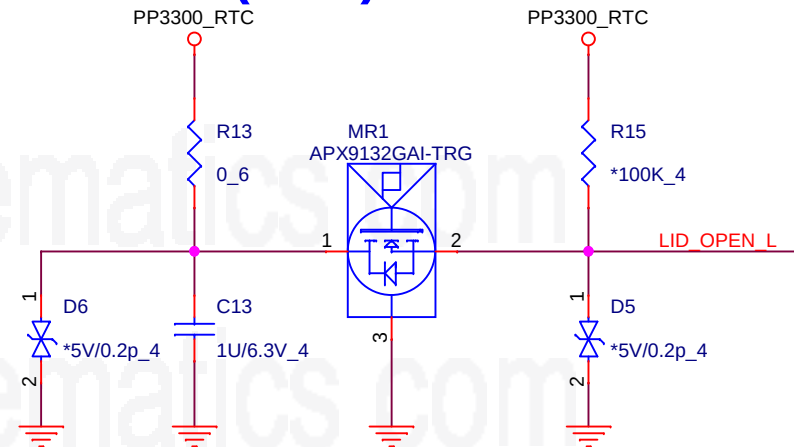
USB2.0: 500mA x1
Charger (DCP): 2A x1
Hall Sensor 3.3V x1

IO Board Connector

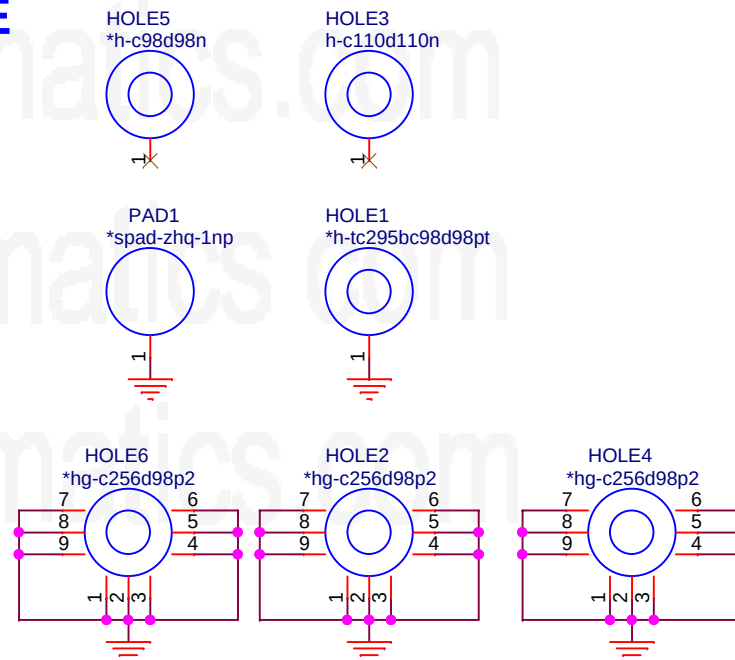


02/12 Add 0.1u on PP5000 & PP3300_RTC for EMI.

Lid Switch (HSR)



HOLE



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FFC CONN /HSR / HOLE

Rev

1A

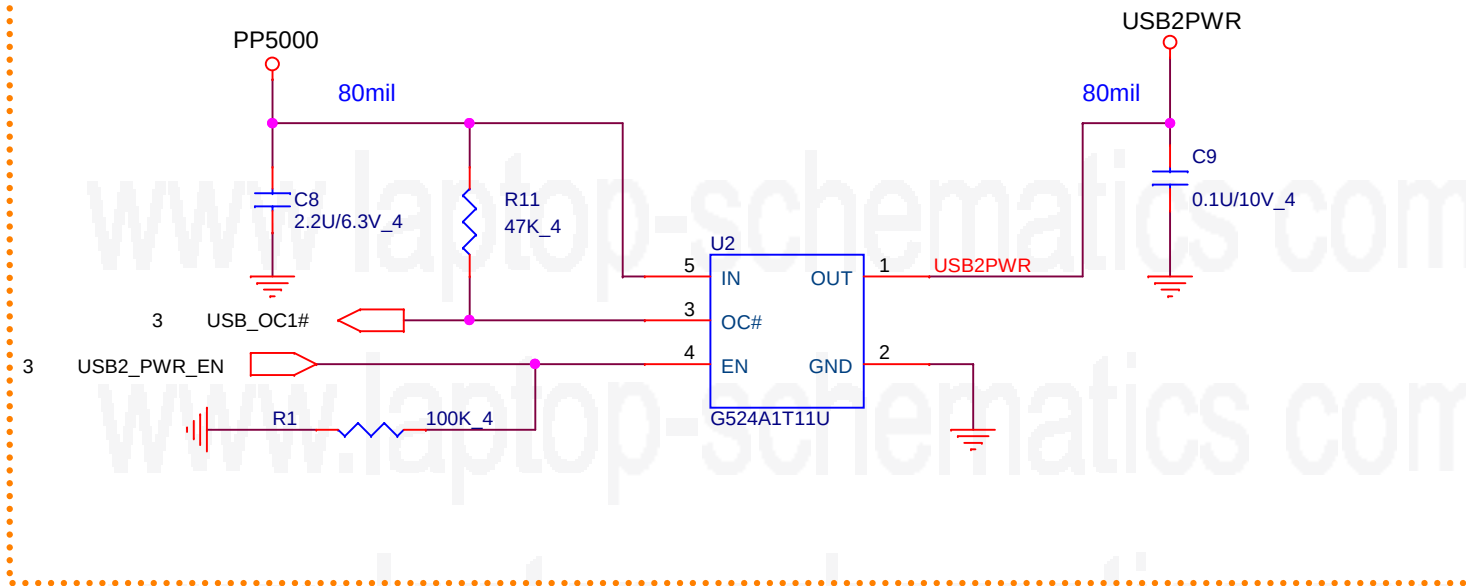
Date: Monday, June 23, 2014

Sheet 3 of 5

of 5

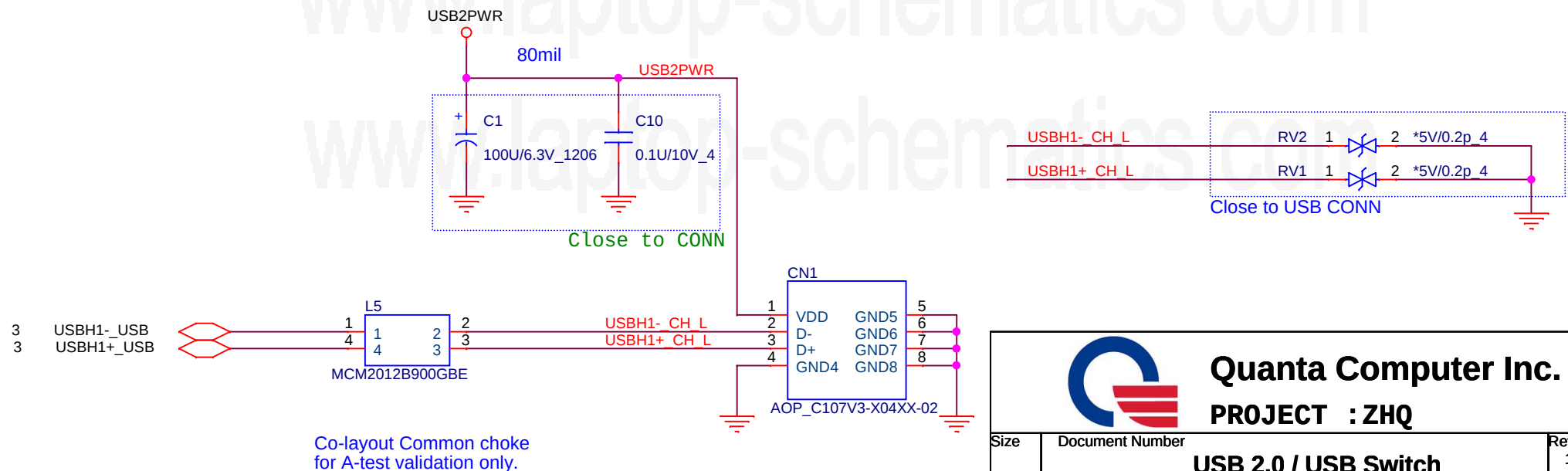
of 5

USB Switch



1/28 Change USB charger to USB switch
 02/11 Change USB power switch (U1) from G547F1P81U to G524C1T11U.
 Change C3 value from 1U to 2.2U.

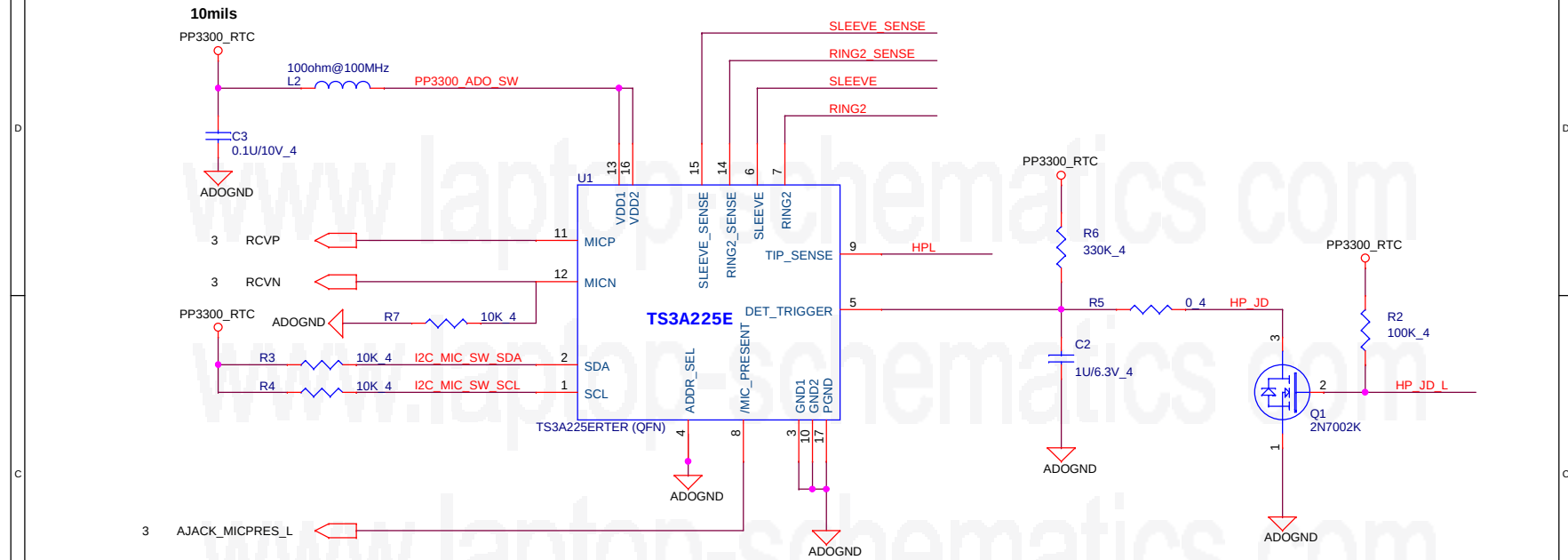
USB 2.0



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PROJECT : ZHQ

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	USB 2.0 / USB Switch	1A
Date:	Monday, June 23, 2014	Sheet 4 of 5

Audio Headset Switch (ADO)



Combo Jack (ADO)

